

### FEATURES

- Low cost 3.3 V CMOS MxFE for broadband modems
- 10-bit DAC converter
  - 2×/4× interpolation filter
  - 200 MSPS DAC update rate
- Integrated 17 dBm line driver with 19.5 dB gain control
- 10-bit, 80 MSPS, ADC converter
  - 12 dB to +48 dB low noise RxPGA (<3 nV/√Hz)
- Third-order, programmable low-pass filter
- Flexible digital data path interface
  - Half- and full-duplex operation
  - Pin compatible with the AD9865
  - Various power-down/reduction modes
- Internal clock multiplier (PLL)
- 2 auxiliary programmable clock outputs
- Available in a 64-lead LFCSP\_VQ

### APPLICATIONS

Broadband wireline networking

### GENERAL DESCRIPTION

The AD9868 is a mixed-signal front-end (MxFE®) IC for transceiver applications requiring Tx path and Rx path functionality with data rates up to 80 MSPS. A lower cost, pin-compatible version of the AD9865, the AD9868 removes the current amplifier (IAMP) IOUTP functionality and limits the PLL VCO operating range of 80 MHz to 200 MHz.

The part is well-suited for half- and full-duplex applications. The digital interface is extremely flexible, allowing simple interfacing to digital back ends that support half- or full-duplex data transfers, often allowing the AD9868 to replace discrete ADC and DAC solutions. Power-saving modes include the ability to reduce power consumption of individual functional blocks or power down unused blocks in half-duplex applications. A serial port interface (SPI) allows software programming of the various functional blocks. An on-chip PLL clock multiplier and synthesizer provide all the required internal clocks, as well as two external clocks, from a single crystal or clock source.

The Tx signal path consists of a 2×/4× low-pass interpolation filter, a 10-bit TxDAC, and a line driver. The transmit path signal bandwidth can be as high as 34 MHz at an input data rate

### FUNCTIONAL BLOCK DIAGRAM

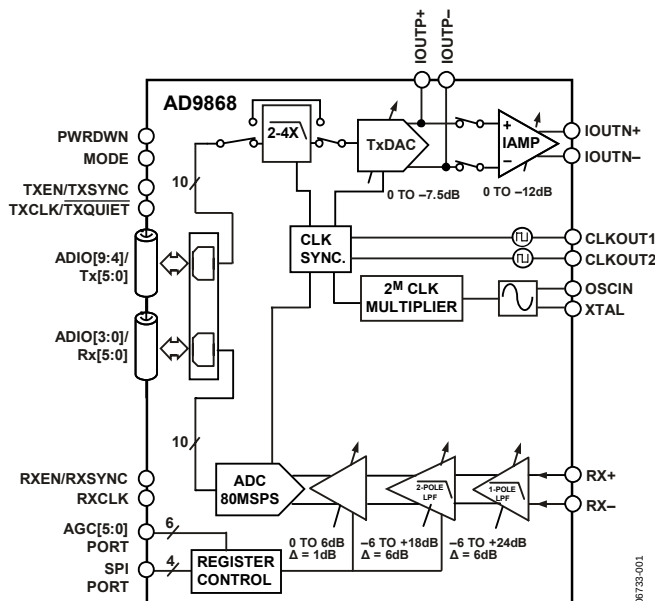


Figure 1.

of 80 MSPS. The TxDAC provides differential current outputs that can be steered directly to an external load or to an internal low distortion current amplifier (IAMP) capable of delivering 17 dBm peak signal power. Tx power can be digitally controlled over a 19.5 dB range in 0.5 dB steps.

The receive path consists of a programmable amplifier (RxPGA), a tunable low-pass filter (LPF), and a 10-bit ADC. The low noise RxPGA has a programmable gain range of –12 dB to +48 dB in 1 dB steps. Its input referred noise is less than 3 nV/√Hz for gain settings beyond 36 dB. The receive path LPF cutoff frequency can be set over a 15 MHz to 35 MHz range or it can be simply bypassed. The 10-bit ADC achieves excellent dynamic performance up to an 80 MSPS span. Both the RxPGA and the ADC offer scalable power consumption allowing power/performance optimization.

The AD9868 provides a highly integrated solution for many broadband modems. It is available in a space-saving package, a 16-lead LFCSP, and is specified over the commercial temperature range (–40°C to +85°C).

#### Rev. 0

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## REVISION HISTORY

5/07—Revision 0: Initial Version

## SPECIFICATIONS

### Tx PATH SPECIFICATIONS

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%,  $f_{\text{OSCIN}}$  = 50 MHz,  $f_{\text{DAC}}$  = 200 MHz,  $R_{\text{SET}}$  = 2.0 k $\Omega$ , unless otherwise noted.

Table 1.

| Parameter                                                                   | Temp | Test Level <sup>1</sup> | Min  | Typ       | Max   | Unit                            |
|-----------------------------------------------------------------------------|------|-------------------------|------|-----------|-------|---------------------------------|
| TxDAC DC CHARACTERISTICS                                                    |      |                         |      |           |       |                                 |
| Resolution                                                                  | Full |                         |      | 10        |       | Bits                            |
| Update Rate                                                                 | Full | II                      |      |           | 200   | MSPS                            |
| Full-Scale Output Current (IOUTP_FS)                                        | Full | IV                      | 2    |           | 25    | mA                              |
| Gain Error <sup>2</sup>                                                     | 25°C | I                       |      | $\pm 2$   |       | % FS                            |
| Offset Error                                                                | 25°C | V                       |      | 2         |       | $\mu$ A                         |
| Voltage Compliance Range                                                    | Full |                         | −1   |           | +1.5  | V                               |
| TxDAC GAIN CONTROL CHARACTERISTICS                                          |      |                         |      |           |       |                                 |
| Minimum Gain                                                                | 25°C | V                       |      | −7.5      |       | dB                              |
| Maximum Gain                                                                | 25°C | V                       |      | 0         |       | dB                              |
| Gain Step Size                                                              | 25°C | V                       |      | 0.5       |       | dB                              |
| Gain Step Accuracy                                                          | 25°C | IV                      |      | Monotonic |       | dB                              |
| Gain Range Error                                                            | 25°C | V                       |      | $\pm 2$   |       | dB                              |
| TxDAC AC CHARACTERISTICS <sup>3</sup>                                       |      |                         |      |           |       |                                 |
| Fundamental                                                                 |      |                         |      | 0.5       |       | dBm                             |
| Signal-to-Noise and Distortion (SINAD)                                      | Full | IV                      | 62.0 | 63.1      |       | dBc                             |
| Signal-to-Noise Ratio (SNR)                                                 | Full | IV                      | 62.5 | 63.2      |       | dBc                             |
| Total Harmonic Distortion (THD)                                             | Full | IV                      |      | −77.7     | −67.0 | dBc                             |
| Spurious-Free Dynamic Range (SFDR)                                          | Full | IV                      | 67.1 | 79.3      |       | dBc                             |
| IAMP DC CHARACTERISTICS                                                     |      |                         |      |           |       |                                 |
| IOUTN Full-Scale Current = IOUTN+ + IOUTN−                                  | Full | IV                      | 2    |           | 105   | mA                              |
| AC Voltage Compliance Range                                                 | Full | IV                      | 1    |           | 3.9   | V                               |
| IAMPN AC CHARACTERISTICS <sup>4</sup>                                       |      |                         |      |           |       |                                 |
| Fundamental                                                                 | 25°C |                         |      | 13        |       | dBm                             |
| IOUTN SFDR (Third Harmonic)                                                 | Full | IV                      | 43.3 | 45.2      |       | dBc                             |
| REFERENCE                                                                   |      |                         |      |           |       |                                 |
| Internal Reference Voltage <sup>5</sup>                                     | 25°C | I                       |      | 1.23      |       | V                               |
| Reference Error                                                             | Full | V                       |      | 0.7       | 3.4   | %                               |
| Reference Drift                                                             | Full | V                       |      | 30        |       | ppm/°C                          |
| Tx DIGITAL FILTER CHARACTERISTICS (2 $\times$ Interpolation)                |      |                         |      |           |       |                                 |
| Latency (Relative to 1/ $f_{\text{DAC}}$ )                                  | Full | V                       |      | 43        |       | Cycles                          |
| −0.2 dB Bandwidth                                                           | Full | V                       |      | 0.2187    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| −3 dB Bandwidth                                                             | Full | V                       |      | 0.2405    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| Stop-Band Rejection (0.289 $f_{\text{DAC}}$ to 0.711 $f_{\text{DAC}}$ )     | Full | V                       |      | 50        |       | dB                              |
| Tx DIGITAL FILTER CHARACTERISTICS (4 $\times$ Interpolation)                |      |                         |      |           |       |                                 |
| Latency (Relative to 1/ $f_{\text{DAC}}$ )                                  | Full | V                       |      | 96        |       | Cycles                          |
| −0.2 dB Bandwidth                                                           | Full | V                       |      | 0.1095    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| −3 dB Bandwidth                                                             | Full | V                       |      | 0.1202    |       | $f_{\text{OUT}}/f_{\text{DAC}}$ |
| Stop Band Rejection (0.289 $f_{\text{OSCIN}}$ to 0.711 $f_{\text{OSCIN}}$ ) | Full | V                       |      | 50        |       | dB                              |
| PLL CLK MULTIPLIER                                                          |      |                         |      |           |       |                                 |
| OSCIN Frequency Range                                                       |      |                         |      |           |       |                                 |
| PLL M Factor Set to 2                                                       | Full | IV                      | 40   |           | 80    | MHz                             |
| PLL M Factor Set to 4                                                       | Full | IV                      | 20   |           | 50    | MHz                             |
| PLL M Factor Set to 8                                                       | Full | IV                      | 10   |           | 25    | MHz                             |
| Internal VCO Frequency Range                                                | Full | IV                      | 80   |           | 200   | MHz                             |
| Duty Cycle                                                                  | Full | II                      | 40   |           | 60    | %                               |

# AD9868

| Parameter                                   | Temp | Test Level <sup>1</sup> | Min | Typ    | Max | Unit   |
|---------------------------------------------|------|-------------------------|-----|--------|-----|--------|
| OSCIN Impedance                             | 25°C | V                       |     | 10  03 |     | MΩ  pF |
| CLKOUT1 Jitter <sup>6</sup>                 | 25°C | III                     |     | 12     |     | ps rms |
| CLKOUT2 Jitter <sup>7</sup>                 | 25°C | III                     |     | 6      |     | ps rms |
| CLKOUT1 and CLKOUT2 Duty Cycle <sup>8</sup> | Full | III                     | 45  |        | 55  | %      |

<sup>1</sup> See the Explanation of Test Levels section.

<sup>2</sup> Gain error and gain temperature coefficients are based on the ADC only (with a fixed 1.23 V external reference and a 1 V p-p differential analog input).

<sup>3</sup> TxDAC IOUTP\_FS = 20 mA, differential output with 1:1 transformer with source and load termination of 50 Ω, f<sub>OUT</sub> = 5 MHz, 4x interpolation.

<sup>4</sup> IOUTN full-scale current = 80 mA, f<sub>OSCIN</sub> = 80 MHz, f<sub>DAC</sub> = 160 MHz, 2x interpolation.

<sup>5</sup> Use external amplifier to drive additional load.

<sup>6</sup> Internal VCO operates at 200 MHz; set to divide-by-1.

<sup>7</sup> Because CLKOUT2 is a divided-down version of OSCIN, its jitter is typically equal to OSCIN.

<sup>8</sup> CLKOUT2 is an inverted replica of OSCIN, if set to divide-by-1.

## Rx PATH SPECIFICATIONS

AVDD = 3.3 V ± 5%, DVDD = CLKVDD = DRVDD = 3.3 V ± 10%, half- or full-duplex operation with CONFIG = 0 default power bias settings, unless otherwise noted.

Table 2.

| Parameter                                                                       | Temp | Test Level <sup>1</sup> | Min | Typ       | Max | Unit   |
|---------------------------------------------------------------------------------|------|-------------------------|-----|-----------|-----|--------|
| <b>Rx INPUT CHARACTERISTICS</b>                                                 |      |                         |     |           |     |        |
| Input Voltage Span                                                              |      |                         |     |           |     |        |
| RxPGA Gain = −10 dB                                                             | Full | III                     |     | 6.33      |     | V p-p  |
| RxPGA Gain = +48 dB                                                             | Full | III                     |     | 8         |     | mV p-p |
| Input Common-Mode Voltage                                                       | 25°C | III                     |     | 1.3       |     | V      |
| Differential Input Impedance                                                    | 25°C | III                     |     | 400  4.0  |     | Ω  pF  |
| Input Bandwidth with RxLPF Disabled, RxPGA = 0 dB                               | 25°C | III                     |     | 53        |     | MHz    |
| Input Voltage Noise Density                                                     |      |                         |     |           |     |        |
| RxPGA Gain = 36 dB, f <sub>−3 dB</sub> = 26 MHz                                 | 25°C | III                     |     | 3.0       |     | nV/√Hz |
| RxPGA Gain = 48 dB, f <sub>−3 dB</sub> = 26 MHz                                 | 25°C | III                     |     | 2.4       |     | nV/√Hz |
| <b>RxPGA CHARACTERISTICS</b>                                                    |      |                         |     |           |     |        |
| Minimum Gain                                                                    | 25°C | III                     |     | −12       |     | dB     |
| Maximum Gain                                                                    | 25°C | III                     |     | 48        |     | dB     |
| Gain Step Size                                                                  | 25°C | III                     |     | 1         |     | dB     |
| Gain Step Accuracy                                                              | 25°C | III                     |     | Monotonic |     | dB     |
| Gain Range Error                                                                | 25°C | III                     |     | 0.5       |     | dB     |
| <b>RxLPF CHARACTERISTICS</b>                                                    |      |                         |     |           |     |        |
| Cutoff Frequency (f <sub>−3 dB</sub> ) Range                                    | Full | III                     | 15  |           | 35  | MHz    |
| Attenuation at 55.2 MHz with f <sub>−3 dB</sub> = 21 MHz                        | 25°C | III                     |     | 20        |     | dB     |
| Pass-Band Ripple                                                                | 25°C | III                     |     | ±1        |     | dB     |
| Settling Time                                                                   |      |                         |     |           |     |        |
| 5 dB RxPGA Gain Step @ f <sub>ADC</sub> = 50 MSPS                               | 25°C | III                     |     | 20        |     | ns     |
| 60 dB RxPGA Gain Step @ f <sub>ADC</sub> = 50 MSPS                              | 25°C | III                     |     | 100       |     | ns     |
| <b>ADC DC CHARACTERISTICS</b>                                                   |      |                         |     |           |     |        |
| Resolution                                                                      | N/A  | N/A                     |     | 10        |     | Bits   |
| Conversion Rate                                                                 | Full | II                      | 20  |           | 80  | MSPS   |
| <b>Rx PATH LATENCY<sup>2</sup></b>                                              |      |                         |     |           |     |        |
| Full-Duplex Interface                                                           | Full | V                       |     | 10.5      |     | Cycles |
| Half-Duplex Interface                                                           | Full | V                       |     | 10.0      |     | Cycles |
| <b>Rx PATH COMPOSITE AC PERFORMANCE @ f<sub>ADC</sub> = 50 MSPS<sup>3</sup></b> |      |                         |     |           |     |        |
| RxPGA Gain = 48 dB (Full-Scale = 8.0 mV p-p)                                    |      |                         |     |           |     |        |
| Signal-to-Noise and Distortion (SINAD)                                          | 25°C | III                     |     | 43.7      |     | dBc    |
| Total Harmonic Distortion (THD)                                                 | 25°C | III                     |     | −71       |     | dBc    |

| Parameter                                                                 | Temp | Test Level <sup>1</sup> | Min  | Typ   | Max   | Unit |
|---------------------------------------------------------------------------|------|-------------------------|------|-------|-------|------|
| RxPGA Gain = 24 dB (Full-Scale = 126 mV p-p)                              |      |                         |      |       |       |      |
| Signal-to-Noise Ratio (SNR)                                               | 25°C | III                     |      | 59    |       | dBc  |
| Total Harmonic Distortion (THD)                                           | 25°C | III                     |      | −67.2 |       | dBc  |
| RxPGA Gain = 0 dB (Full-Scale = 2.0 V p-p)                                |      |                         |      |       |       |      |
| Signal-to-Noise and Distortion (SINAD)                                    | Full | IV                      | 58   | 59    |       | dBc  |
| Total Harmonic Distortion (THD)                                           | Full | IV                      |      | −66   | −62.9 | dBc  |
| Rx PATH COMPOSITE AC PERFORMANCE @ $f_{ADC} = 80$ MSPS <sup>4</sup>       |      |                         |      |       |       |      |
| RxPGA Gain = 48 dB (Full-Scale = 8.0 mV p-p)                              |      |                         |      |       |       |      |
| Signal-to-Noise Ratio (SNR)                                               | 25°C | III                     |      | 41.8  |       | dBc  |
| Total Harmonic Distortion (THD)                                           | 25°C | III                     |      | −67   |       | dBc  |
| RxPGA Gain = 24 dB (Full-Scale = 126 mV p-p)                              |      |                         |      |       |       |      |
| Signal-to-Noise Ratio (SNR)                                               | 25°C | III                     |      | 58.6  |       | dBc  |
| Total Harmonic Distortion (THD)                                           | 25°C | III                     |      | −62.9 |       | dBc  |
| RxPGA Gain = 0 dB (Full-Scale = 2.0 V p-p)                                |      |                         |      |       |       |      |
| Signal-to-Noise Ratio (SNR)                                               | 25°C | II                      | 58.9 | 59.6  |       | dBc  |
| Total Harmonic Distortion (THD)                                           | 25°C | II                      |      | −69.7 | −59.8 | dBc  |
| Rx-to-Tx PATH FULL-DUPLEX ISOLATION (1 V p-p, 10 MHz Sine Wave Tx Output) |      |                         |      |       |       |      |
| RxPGA Gain = 40 dB                                                        |      |                         |      |       |       |      |
| IOUTP± Pins to RX± Pins                                                   | 25°C | III                     |      | 83    |       | dBc  |
| RxPGA Gain = 0 dB                                                         |      |                         |      |       |       |      |
| IOUTP± Pins to RX± Pins                                                   | 25°C | III                     |      | 123   |       | dBc  |

<sup>1</sup> See the Explanation of Test Levels section.

<sup>2</sup> Includes RxPGA, ADC pipeline, and ADIO bus delay relative to  $f_{ADC}$ .

<sup>3</sup>  $f_{IN} = 5$  MHz,  $A_{IN} = -1.0$  dBFS, LPF cutoff frequency set to 15.5 MHz with Register 0x08 = 0x80.

<sup>4</sup>  $f_{IN} = 5$  MHz,  $A_{IN} = -1.0$  dBFS, LPF cutoff frequency set to 26 MHz with Register 0x08 = 0x80.

**POWER SUPPLY SPECIFICATIONS**

AVDD = 3.3 V, DVDD = CLKVDD = DRVDD = 3.3 V, R<sub>SET</sub> = 2 kΩ, full-duplex operation with f<sub>DATA</sub> = 80 MSPS<sup>1</sup>, unless otherwise noted.

**Table 3.**

| Parameter                                                                                         | Temp | Test Level <sup>2</sup> | Min   | Typ  | Max   | Unit |
|---------------------------------------------------------------------------------------------------|------|-------------------------|-------|------|-------|------|
| <b>SUPPLY VOLTAGES</b>                                                                            |      |                         |       |      |       |      |
| AVDD                                                                                              | Full | V                       | 3.135 | 3.3  | 3.465 | V    |
| CLKVDD                                                                                            | Full | V                       | 3.0   | 3.3  | 3.6   | V    |
| DVDD                                                                                              | Full | V                       | 3.0   | 3.3  | 3.6   | V    |
| DRVDD                                                                                             | Full | V                       | 3.0   | 3.3  | 3.6   | V    |
| IS_TOTAL (Total Supply Current)                                                                   | Full | II                      |       | 406  | 475   | mA   |
| <b>POWER CONSUMPTION</b>                                                                          |      |                         |       |      |       |      |
| I <sub>AVDD</sub> + I <sub>CLKVDD</sub> (Analog Supply Current)                                   | Full | IV                      |       | 311  | 342   | mA   |
| I <sub>DVDD</sub> + I <sub>DRVDD</sub> (Digital Supply Current)                                   | Full | IV                      |       | 95   | 133   | mA   |
| <b>POWER CONSUMPTION (Half-Duplex Operation with f<sub>DATA</sub> = 50 MSPS)<sup>3</sup></b>      |      |                         |       |      |       |      |
| <b>Tx Mode</b>                                                                                    |      |                         |       |      |       |      |
| I <sub>AVDD</sub> + I <sub>CLKVDD</sub>                                                           | 25°C | IV                      |       | 112  | 130   | mA   |
| I <sub>DVDD</sub> + I <sub>DRVDD</sub>                                                            | 25°C | IV                      |       | 46   | 49.5  | mA   |
| <b>Rx Mode</b>                                                                                    |      |                         |       |      |       |      |
| I <sub>AVDD</sub> + I <sub>CLKVDD</sub>                                                           | 25°C | IV                      |       | 225  | 253   | mA   |
| I <sub>DVDD</sub> + I <sub>DRVDD</sub>                                                            | 25°C | IV                      |       | 36.5 | 39    | mA   |
| <b>POWER CONSUMPTION OF FUNCTIONAL BLOCKS<sup>1</sup> (I<sub>AVDD</sub> + I<sub>CLKVDD</sub>)</b> |      |                         |       |      |       |      |
| RxPGA and LPF                                                                                     | 25°C | III                     |       | 87   |       | mA   |
| ADC                                                                                               | 25°C | III                     |       | 108  |       | mA   |
| TxDAC                                                                                             | 25°C | III                     |       | 38   |       | mA   |
| IAMP (Programmable)                                                                               | 25°C | III                     | 10    |      | 100   | mA   |
| Reference                                                                                         | 25°C | III                     |       | 170  |       | mA   |
| CLK PLL and Synthesizer                                                                           | 25°C | III                     |       | 107  |       | mA   |
| <b>MAXIMUM ALLOWABLE POWER DISSIPATION</b>                                                        | Full | IV                      |       |      | 1.66  | W    |
| <b>STANDBY POWER CONSUMPTION</b>                                                                  |      |                         |       |      |       |      |
| IS_TOTAL (Total Supply Current)                                                                   | Full |                         |       | 13   |       | mA   |
| <b>POWER-DOWN DELAY (Using PWRDWN Pin)</b>                                                        |      |                         |       |      |       |      |
| RxPGA and LPF                                                                                     | 25°C | III                     |       | 440  |       | ns   |
| ADC                                                                                               | 25°C | III                     |       | 12   |       | ns   |
| TxDAC                                                                                             | 25°C | III                     |       | 20   |       | ns   |
| IAMP                                                                                              | 25°C | III                     |       | 20   |       | ns   |
| CLK PLL and Synthesizer                                                                           | 25°C | III                     |       | 27   |       | ns   |
| <b>POWER-UP DELAY (Using PWRDWN Pin)</b>                                                          |      |                         |       |      |       |      |
| RxPGA and LPF                                                                                     | 25°C | III                     |       | 7.8  |       | μs   |
| ADC                                                                                               | 25°C | III                     |       | 88   |       | ns   |
| TxDAC                                                                                             | 25°C | III                     |       | 13   |       | μs   |
| IAMP                                                                                              | 25°C | III                     |       | 20   |       | ns   |
| CLK PLL and Synthesizer                                                                           | 25°C | III                     |       | 20   |       | μs   |

<sup>1</sup> Default power-up settings for MODE = high and CONFIG = low, IOUTP\_FS = 20 mA, does not include IAMP current consumption, which is application dependent.

<sup>2</sup> See the Explanation of Test Levels section.

<sup>3</sup> Default power-up settings for MODE = low and CONFIG = low.

**DIGITAL SPECIFICATIONS**

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, R<sub>SET</sub> = 2 k $\Omega$ , unless otherwise noted.

**Table 4.**

| Parameter                                               | Temp | Test Level <sup>1</sup> | Min         | Typ     | Max | Unit         |
|---------------------------------------------------------|------|-------------------------|-------------|---------|-----|--------------|
| CMOS LOGIC INPUTS                                       |      |                         |             |         |     |              |
| High Level Input Voltage                                | Full | VI                      | DRVDD – 0.7 |         |     | V            |
| Low Level Input Voltage                                 | Full | VI                      |             |         | 0.4 | V            |
| Input Leakage Current                                   |      |                         |             |         | 12  | $\mu$ A      |
| Input Capacitance                                       | Full | VI                      |             | 3       |     | pF           |
| CMOS LOGIC OUTPUTS (C <sub>LOAD</sub> = 5 pF)           |      |                         |             |         |     |              |
| High Level Output Voltage (I <sub>OH</sub> = 1 mA)      | Full | VI                      | DRVDD – 0.7 |         |     | V            |
| Low Level Output Voltage (I <sub>OH</sub> = 1 mA)       | Full | VI                      |             |         | 0.4 | V            |
| Output Rise/Fall Time                                   |      |                         |             |         |     |              |
| High Strength Mode and C <sub>LOAD</sub> = 15 pF        | Full | VI                      |             | 1.5/2.3 |     | ns           |
| Low Strength Mode and C <sub>LOAD</sub> = 15 pF         | Full | VI                      |             | 1.9/2.7 |     | ns           |
| High Strength Mode and C <sub>LOAD</sub> = 5 pF         | Full | VI                      |             | 0.7/0.7 |     | ns           |
| Low Strength Mode and C <sub>LOAD</sub> = 5 pF          | Full | VI                      |             | 1.0/1.0 |     | ns           |
| RESET                                                   |      |                         |             |         |     |              |
| Minimum Low Pulse Width (Relative to f <sub>ADC</sub> ) |      |                         | 1           |         |     | Clock cycles |

<sup>1</sup> See the Explanation of Test Levels section.

**SERIAL PORT TIMING SPECIFICATIONS**

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

**Table 5.**

| Parameter                                                                 | Temp | Test Level <sup>1</sup> | Min | Typ | Max | Unit |
|---------------------------------------------------------------------------|------|-------------------------|-----|-----|-----|------|
| WRITE OPERATION (See Figure 5)                                            |      |                         |     |     |     |      |
| SCLK Clock Rate (f <sub>SCLK</sub> )                                      | Full | IV                      |     |     | 32  | MHz  |
| SCLK Clock High (t <sub>HI</sub> )                                        | Full | IV                      | 14  |     |     | ns   |
| SCLK Clock Low (t <sub>LOW</sub> )                                        | Full | IV                      | 14  |     |     | ns   |
| SDIO to SCLK Setup Time (t <sub>DS</sub> )                                | Full | IV                      | 14  |     |     | ns   |
| SCLK to SDIO Hold Time (t <sub>DH</sub> )                                 | Full | IV                      | 0   |     |     | ns   |
| $\overline{\text{SEN}}$ to SCLK Setup Time (t <sub>s</sub> )              | Full | IV                      | 14  |     |     | ns   |
| SCLK to $\overline{\text{SEN}}$ Hold Time (t <sub>h</sub> )               | Full | IV                      | 0   |     |     | ns   |
| READ OPERATION (See Figure 6 and Figure 7)                                |      |                         |     |     |     |      |
| SCLK Clock Rate (f <sub>SCLK</sub> )                                      | Full | IV                      |     |     | 32  | MHz  |
| SCLK Clock High (t <sub>HI</sub> )                                        | Full | IV                      | 14  |     |     | ns   |
| SCLK Clock Low (t <sub>LOW</sub> )                                        | Full | IV                      | 14  |     |     | ns   |
| SDIO to SCLK Setup Time (t <sub>DS</sub> )                                | Full | IV                      | 14  |     |     | ns   |
| SCLK to SDIO Hold Time (t <sub>DH</sub> )                                 | Full | IV                      | 0   |     |     | ns   |
| SCLK to SDIO (or SDO) Data Valid Time (t <sub>DV</sub> )                  | Full | IV                      |     |     | 14  | ns   |
| $\overline{\text{SEN}}$ to SDIO Output Valid to High-Z (t <sub>EZ</sub> ) | Full | IV                      |     | 2   |     | ns   |

<sup>1</sup> See the Explanation of Test Levels section.

## HALF-DUPLEX DATA INTERFACE (ADIO PORT) TIMING SPECIFICATIONS

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

Table 6.

| Parameter                                     | Temp | Test Level <sup>1</sup> | Min | Typ | Max | Unit |
|-----------------------------------------------|------|-------------------------|-----|-----|-----|------|
| READ OPERATION <sup>2</sup> (See Figure 9)    |      |                         |     |     |     |      |
| Output Data Rate                              | Full | II                      | 20  |     | 80  | MSPS |
| Three-State Output Enable Time ( $t_{PZL}$ )  | Full | II                      |     |     | 3   | ns   |
| Three-State Output Disable Time ( $t_{PLZ}$ ) | Full | II                      |     |     | 3   | ns   |
| Rx Data Valid Time ( $t_{VT}$ )               | Full | II                      | 1.5 |     |     | ns   |
| Rx Data Output Delay ( $t_{OD}$ )             | Full | II                      |     |     | 4   | ns   |
| WRITE OPERATION (See Figure 8)                |      |                         |     |     |     |      |
| Input Data Rate (2 $\times$ Interpolation)    | Full | II                      | 40  |     | 80  | MSPS |
| Input Data Rate (4 $\times$ Interpolation)    | Full | II                      | 20  |     | 50  | MSPS |
| Tx Data Setup Time ( $t_{DS}$ )               | Full | II                      | 1   |     |     | ns   |
| Tx Data Hold Time ( $t_{DH}$ )                | Full | II                      | 2.5 |     |     | ns   |
| Latch Enable Time ( $t_{EN}$ )                | Full | II                      |     |     | 3   | ns   |
| Latch Disable Time ( $t_{DIS}$ )              | Full | II                      |     |     | 3   | ns   |

<sup>1</sup> See the Explanation of Test Levels section.

<sup>2</sup>  $C_{LOAD}$  = 5 pF for digital data outputs.

## FULL-DUPLEX DATA INTERFACE (Tx AND Rx PORT) TIMING SPECIFICATIONS

AVDD = 3.3 V  $\pm$  5%, DVDD = CLKVDD = DRVDD = 3.3 V  $\pm$  10%, unless otherwise noted.

Table 7.

| Parameter                                      | Temp | Test Level <sup>1</sup> | Min | Typ | Max | Unit |
|------------------------------------------------|------|-------------------------|-----|-----|-----|------|
| Tx PATH INTERFACE (See Figure 12)              |      |                         |     |     |     |      |
| Input Nibble Rate (2 $\times$ Interpolation)   | Full | II                      | 80  |     | 160 | MSPS |
| Input Nibble Rate (4 $\times$ Interpolation)   | Full | II                      | 40  |     | 100 | MSPS |
| Tx Data Setup Time ( $t_{DS}$ )                | Full | II                      | 2.5 |     |     | ns   |
| Tx Data Hold Time ( $t_{DH}$ )                 | Full | II                      | 1.5 |     |     | ns   |
| Rx PATH INTERFACE <sup>2</sup> (See Figure 13) |      |                         |     |     |     |      |
| Output Nibble Rate                             | Full | II                      | 40  |     | 160 | MSPS |
| Rx Data Valid Time ( $t_{DV}$ )                | Full | II                      | 3   |     |     | ns   |
| Rx Data Hold Time ( $t_{DH}$ )                 | Full | II                      | 0   |     |     | ns   |

<sup>1</sup> See the Explanation of Test Levels section.

<sup>2</sup>  $C_{LOAD}$  = 5 pF for digital data outputs.

## ABSOLUTE MAXIMUM RATINGS

Table 8.

| Parameter                             | Rating                  |
|---------------------------------------|-------------------------|
| <b>ELECTRICAL</b>                     |                         |
| AVDD, CLKVDD Voltage                  | 3.9 V maximum           |
| DVDD, DRVDD Voltage                   | 3.9 V maximum           |
| RX+, RX−, REFT, REFB                  | −0.3 V to AVDD + 0.3 V  |
| IOUTP+, IOUTP−                        | −1.5 V to AVDD + 0.3 V  |
| IOUTN+, IOUTN−                        | −0.3 V to +3.9 V        |
| OSCIN, XTAL                           | −0.3 V to CLVDD + 0.3 V |
| REFIO, REFADJ                         | −0.3 V to AVDD + 0.3 V  |
| Digital Input and Output Voltage      | −0.3 V to DRVDD + 0.3 V |
| Digital Output Current                | 5 mA maximum            |
| <b>ENVIRONMENTAL</b>                  |                         |
| Operating Temperature Range (Ambient) | −40°C to +85°C          |
| Maximum Junction Temperature          | 125°C                   |
| Lead Temperature (Soldering, 10 sec)  | 150°C                   |
| Storage Temperature Range (Ambient)   | −65°C to +150°C         |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL CHARACTERISTICS

Thermal Resistance: 64-lead LFCSP (4-layer board).

$\theta_{JA} = 24^{\circ}\text{C/W}$  (paddle soldered to ground plane, 0 LPM air).

$\theta_{JA} = 30.8^{\circ}\text{C/W}$  (paddle not soldered to ground plane, 0 LPM air).

## EXPLANATION OF TEST LEVELS

- I. 100% production tested.
- II. 100% production tested at 25°C and guaranteed by design and characterization at specified temperatures.
- III. Sample tested only.
- IV. Parameter is guaranteed by design and characterization testing.
- V. Parameter is a typical value only.
- VI. 100% production tested at 25°C and guaranteed by design and characterization for industrial temperature range.

## ESD CAUTION



### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

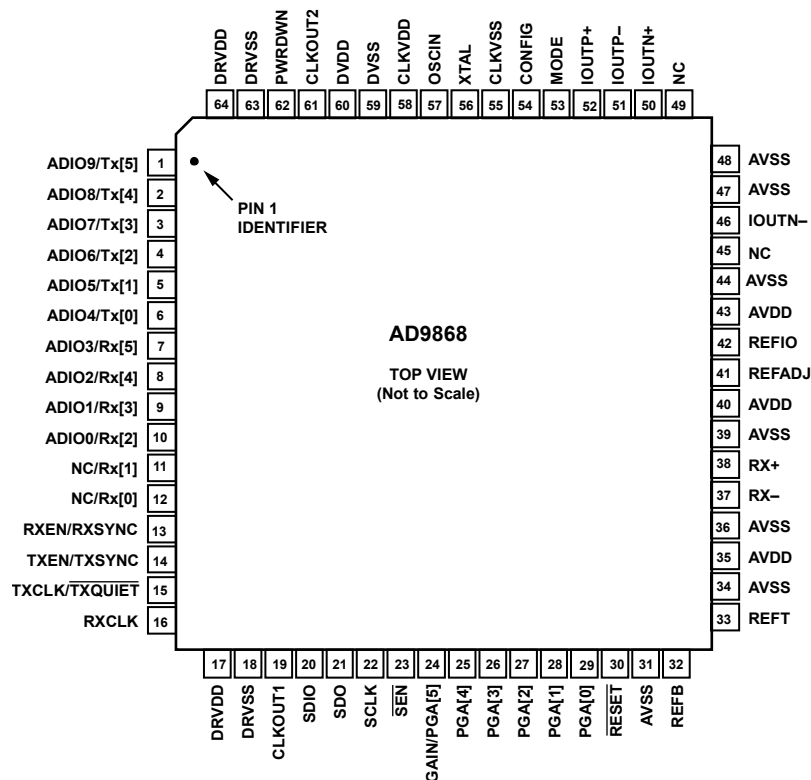


Figure 2. Pin Configuration

Table 9. Pin Function Descriptions

| Pin No. | Mnemonic                  | Mode <sup>1</sup> | Description                                                                 |
|---------|---------------------------|-------------------|-----------------------------------------------------------------------------|
| 1       | ADIO9<br>Tx[5]            | HD<br>FD          | MSB of ADIO Buffer.<br>MSB of Tx Nibble Input.                              |
| 2 to 5  | ADIO8 to ADIO5<br>Tx[4:1] | HD<br>FD          | Bit 8 to Bit 5 of ADIO Buffer.<br>Bit 4 to Bit 1 of Tx Nibble Input.        |
| 6       | ADIO4<br>Tx[0]            | HD<br>FD          | Bit 4 of ADIO Buffer.<br>LSB of Tx Nibble Input.                            |
| 7       | ADIO3<br>Rx[5]            | HD<br>FD          | Bit 3 of ADIO Buffer.<br>MSB of Rx Nibble Output.                           |
| 8, 9    | ADIO2, ADIO1<br>Rx[4:3]   | HD<br>FD          | Bit 2 to Bit 1 of ADIO Buffer.<br>Bit 4 to Bit 3 of Rx Nibble Output.       |
| 10      | ADIO0<br>Rx[2]            | HD<br>FD          | LSB of ADIO Buffer.<br>Bit 2 of Rx Nibble Output.                           |
| 11      | NC<br>Rx[1]               | HD<br>FD          | No Connect.<br>Bit 1 of Rx Nibble Output.                                   |
| 12      | NC<br>Rx[0]               | HD<br>FD          | No Connect.<br>LSB of Rx Nibble Output.                                     |
| 13      | RXEN<br>RXSYNC            | HD<br>FD          | ADIO Buffer Control Input.<br>Rx Data Synchronization Output.               |
| 14      | TXEN<br>TXSYNC            | HD<br>FD          | Tx Path Enable Input.<br>Tx Data Synchronization Input.                     |
| 15      | TXCLK<br>TXQUIET          | HD<br>FD          | ADIO Sample Clock Input.<br>Fast TxDAC/IAMP Power-Down.                     |
| 16      | RXCLK                     | HD<br>FD          | ADIO Request Clock Input.<br>Rx and Tx Clock Output at $2 \times f_{ADC}$ . |

| Pin No.                    | Mnemonic           | Mode <sup>1</sup> | Description                                               |
|----------------------------|--------------------|-------------------|-----------------------------------------------------------|
| 17, 64                     | DRVDD              |                   | Digital Output Driver Supply Input.                       |
| 18, 63                     | DRVSS              |                   | Digital Output Driver Supply Return.                      |
| 19                         | CLKOUT1            |                   | $f_{ADC}/N$ Clock Output ( $R = 1, 2, \text{ or } 3$ ).   |
| 20                         | SDIO               |                   | Serial Port Data Input/Output.                            |
| 21                         | SDO                |                   | Serial Port Data Output.                                  |
| 22                         | SCLK               |                   | Serial Port Clock Input.                                  |
| 23                         | $\overline{SEN}$   |                   | Serial Port Enable Input.                                 |
| 24                         | GAIN               | FD                | Tx Data Port (Tx[5:0]) Mode Select.                       |
|                            | PGA[5]             | HD or FD          | MSB of PGA Input Data Port.                               |
| 25 to 29                   | PGA[4:0]           | HD or FD          | Bit 4 to Bit 0 of PGA Input Data Port.                    |
| 30                         | $\overline{RESET}$ |                   | Reset Input (Active Low).                                 |
| 31, 34, 36, 39, 44, 47, 48 | AVSS               |                   | Analog Supply Return.                                     |
| 32, 33                     | REFB, REFT         |                   | ADC Reference Decoupling Nodes.                           |
| 35, 40, 43                 | AVDD               |                   | Analog Power Supply Input.                                |
| 37, 38                     | RX $-$ , RX $+$    |                   | Receive Path $-$ and $+$ Analog Inputs.                   |
| 41                         | REFADJ             |                   | TxDAC Full-Scale Current Adjust.                          |
| 42                         | REFIO              |                   | TxDAC Reference Input/Output.                             |
| 45, 49                     | NC                 |                   | Do Not Connect; Leave Open.                               |
| 46                         | IOUTN $-$          |                   | $-$ Tx Mirror Current Output Sink.                        |
| 50                         | IOUTN $+$          |                   | $+$ Tx Mirror Current Output Sink.                        |
| 51                         | IOUTP $-$          |                   | $-$ TxDAC Current Output Source.                          |
| 52                         | IOUTP $+$          |                   | $+$ TxDAC Current Output Source.                          |
| 53                         | MODE               |                   | Digital Interface Mode Select Input, Low = HD, High = FD. |
| 54                         | CONFIG             |                   | Power-Up SPI Register Default Setting Input.              |
| 55                         | CLKVSS             |                   | Clock Oscillator/Synthesizer Supply Return.               |
| 56                         | XTAL               |                   | Crystal Oscillator Inverter Output.                       |
| 57                         | OSCIN              |                   | Crystal Oscillator Inverter Input.                        |
| 58                         | CLKVDD             |                   | Clock Oscillator/Synthesizer Supply.                      |
| 59                         | DVSS               |                   | Digital Supply Return.                                    |
| 60                         | DVDD               |                   | Digital Supply Input.                                     |
| 61                         | CLKOUT2            |                   | $f_{OSCIN}/L$ Clock Output ( $L = 1, 2, \text{ or } 4$ ). |
| 62                         | PWRDWN             |                   | Power-Down Input.                                         |

<sup>1</sup> HD = half-duplex mode; FD = full-duplex mode.

## SERIAL PORT

Table 10. SPI Register Mapping

| Address<br>(Hex)                          | Bit <sup>1</sup> | Description                       | Width | Power-Up Default Value    |            |                           | Comments                                                                                                                                 |
|-------------------------------------------|------------------|-----------------------------------|-------|---------------------------|------------|---------------------------|------------------------------------------------------------------------------------------------------------------------------------------|
|                                           |                  |                                   |       | MODE = 0<br>(Half-Duplex) |            | MODE = 1<br>(Full-Duplex) |                                                                                                                                          |
|                                           |                  |                                   |       | CONFIG = 0                | CONFIG = 1 | CONFIG = 0                |                                                                                                                                          |
| SPI PORT CONFIGURATION AND SOFTWARE RESET |                  |                                   |       |                           |            |                           |                                                                                                                                          |
| 0x00                                      | 7                | 4-Wire SPI                        | 1     | 0                         | 0          | 0                         | Default SPI configuration is 3-wire, MSB first.                                                                                          |
|                                           | 6                | SPI LSB First                     | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 5                | Software Reset                    | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
| POWER CONTROL REGISTERS (Via PWRDWN Pin)  |                  |                                   |       |                           |            |                           |                                                                                                                                          |
| 0x01                                      | 7                | CLK Synthesizer                   | 1     | 0                         | 0          | 0                         | PWRDWN = 0.<br>Default setting is for all blocks powered on.                                                                             |
|                                           | 6                | TxDAC/IAMP                        | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 5                | Tx Digital                        | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 4                | REF                               | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 3                | ADC CML                           | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 2                | ADC                               | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 1                | PGA Bias                          | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 0                | RxPGA                             | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
| 0x02                                      | 7                | CLK Synthesizer                   | 1     | 0                         | 0          | 0                         | PWRDWN = 1.<br>Default setting is for all functional blocks powered down except PLL.                                                     |
|                                           | 6                | TxDAC/IAMP                        | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 5                | Tx Digital                        | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 4                | REF                               | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 3                | ADC CML                           | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 2                | ADC                               | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 1                | PGA Bias                          | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
|                                           | 0                | RxPGA                             | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
| HALF-DUPLEX POWER CONTROL                 |                  |                                   |       |                           |            |                           |                                                                                                                                          |
| 0x03                                      | 7:3              | Tx OFF Delay                      | 5     | 0xFF                      | 0xFF       | N/A                       | Default setting is for TXEN input to control power-on/power-off of Tx/Rx path. Tx driver delayed by 31 1/f <sub>DATA</sub> clock cycles. |
|                                           | 2                | Rx_TXEN                           | 1     | 0xFF                      | 0xFF       | N/A                       |                                                                                                                                          |
|                                           | 1                | Tx PWRDN                          | 1     | 0xFF                      | 0xFF       | N/A                       |                                                                                                                                          |
|                                           | 0                | Rx PWRDN                          | 1     | 0xFF                      | 0xFF       | N/A                       |                                                                                                                                          |
| PLL CLOCK MULTIPLIER/SYNTHESIZER CONTROL  |                  |                                   |       |                           |            |                           |                                                                                                                                          |
| 0x04                                      | 4                | f <sub>ADC</sub> from PLL         | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 3:2              | PLL Divide-N                      | 2     | 00                        | 00         | 00                        |                                                                                                                                          |
|                                           | 1:0              | PLL Multiplier-M                  | 2     | 01                        | 10         | 01                        |                                                                                                                                          |
| 0x05                                      | 2                | OSCIN to RXCLK                    | 1     | 0                         | 0          | 0                         | Full-duplex RXCLK normally at nibble rate.                                                                                               |
|                                           | 1                | Invert RXCLK                      | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 0                | Disable RXCLK                     | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
| 0x06                                      | 7:6              | CLKOUT2 Divide                    | 2     | 01                        | 01         | 01                        | Default setting is CLKOUT2 and CLKOUT1 enabled with divide-by-2.                                                                         |
|                                           | 5                | CLKOUT2 Invert                    | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 4                | CLKOUT2 Disable                   | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 3:2              | CLKOUT1 Divide                    | 2     | 01                        | 01         | 01                        |                                                                                                                                          |
|                                           | 1                | CLKOUT1 Invert                    | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
|                                           | 0                | CLKOUT1 Disable                   | 1     | 0                         | 0          | 0                         |                                                                                                                                          |
| Rx PATH CONTROL                           |                  |                                   |       |                           |            |                           |                                                                                                                                          |
| 0x07                                      | 5                | Initiate Offset Cal.              | 1     | 0                         | 0          | 0                         | Default setting has LPF on.<br>Rx path at nominal power bias setting for CONFIG = 0 and low power for CONFIG = 1.                        |
|                                           | 4                | Rx Low Power                      | 1     | 0                         | 1          | 0                         |                                                                                                                                          |
|                                           | 0                | Enable Rx LPF                     | 1     | 1                         | 1          | 1                         |                                                                                                                                          |
| 0x08                                      | 7:0              | Rx Filter Target Cutoff Frequency | 8     | 0x80                      | 0x61       | 0x80                      | Refer to the Low-Pass Filter section.                                                                                                    |

| Address<br>(Hex)                                        | Bit <sup>1</sup> | Description                        | Width | Power-Up Default Value    |            |                           | Comments                                                                                                                                                                                         |
|---------------------------------------------------------|------------------|------------------------------------|-------|---------------------------|------------|---------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                                         |                  |                                    |       | MODE = 0<br>(Half-Duplex) |            | MODE = 1<br>(Full-Duplex) |                                                                                                                                                                                                  |
|                                                         |                  |                                    |       | CONFIG = 0                | CONFIG = 1 | CONFIG = 0                |                                                                                                                                                                                                  |
| Tx/Rx PATH GAIN CONTROL                                 |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x09                                                    | 6                | Enable SPI Rx Gain                 | 1     | 0x00                      | 0x00       | 0x00                      | Default setting is for hardware Rx gain code via PGA or Tx data port.                                                                                                                            |
|                                                         | 5:0              | Rx Gain Code                       | 6     | 0x00                      | 0x00       | 0x00                      |                                                                                                                                                                                                  |
| 0x0A                                                    | 6                | Enable SPI Tx Gain                 | 1     | 0x7F                      | 0x7F       | 0x7F                      | Default setting is for Tx gain code via SPI control.                                                                                                                                             |
|                                                         | 5:0              | Tx Gain Code                       | 6     | 0x7F                      | 0x7F       | 0x7F                      |                                                                                                                                                                                                  |
| TxPGA AND RxPGA CONTROL                                 |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x0B                                                    | 6                | PGA Code for Tx                    | 1     | 0                         | 0          | 0                         | Default setting is RxPGA control active via PGA port.                                                                                                                                            |
|                                                         | 5                | PGA Code for Rx                    | 1     | 1                         | 1          | 1                         |                                                                                                                                                                                                  |
|                                                         | 3                | Force Gain Strobe                  | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 2                | Rx Gain on Tx Port                 | 1     | 0                         | 0          | 1                         |                                                                                                                                                                                                  |
|                                                         | 1                | 3-Bit RxPGA Port                   | 1     | 0                         | 1          | 0                         |                                                                                                                                                                                                  |
| Tx DIGITAL FILTER AND INTERFACE                         |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x0C                                                    | 7:6              | Interpolation Factor               | 2     | 01                        | 00         | 01                        | Default setting is 2× interpolation with LPF response. Data format is straight binary for half-duplex and twos complement for full-duplex interface.                                             |
|                                                         | 4                | Invert TXEN/TXSYNC                 | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 3                | Tx 5/5 Nibble <sup>2</sup>         | 1     | N/A                       | N/A        | 0                         |                                                                                                                                                                                                  |
|                                                         | 2                | LS Nibble First <sup>2</sup>       | 1     | N/A                       | N/A        | 0                         |                                                                                                                                                                                                  |
|                                                         | 1                | TXCLK Neg. Edge                    | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 0                | Twos Complement                    | 1     | 0                         | 0          | 1                         |                                                                                                                                                                                                  |
| Rx INTERFACE AND ANALOG/DIGITAL LOOPBACK                |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x0D                                                    | 7                | Analog Loopback                    | 1     | 0                         | 0          | 0                         | Data format is straight binary for half-duplex and twos complement for full-duplex interface. Analog loopback: ADC Rx data fed back to TxDAC. Digital loopback: Tx input data to Rx output port. |
|                                                         | 6                | Digital Loopback <sup>2</sup>      | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 5                | Rx Port Three-State                | 1     | N/A                       | N/A        | 0                         |                                                                                                                                                                                                  |
|                                                         | 4                | Invert RXEN/RXSYNC                 | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 3                | Rx 5/5 Nibble                      | 1     | N/A                       | N/A        | 0                         |                                                                                                                                                                                                  |
|                                                         | 2                | LS Nibble First                    | 1     | N/A                       | N/A        | 0                         |                                                                                                                                                                                                  |
|                                                         | 1                | RXCLK Neg. Edge                    | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
|                                                         | 0                | Twos Complement                    | 1     | 0                         | 0          | 1                         |                                                                                                                                                                                                  |
| DIGITAL OUTPUT DRIVE STRENGTH, TxDAC OUTPUT, AND REV ID |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x0E                                                    | 7                | Low Digital Drive Strength         | 1     | 0                         | 0          | 0                         | Default setting is for high drive strength and IAMP enabled.                                                                                                                                     |
|                                                         | 0                | TxDAC Output                       | 1     | 0                         | 0          | 0                         |                                                                                                                                                                                                  |
| 0x0F                                                    | 3:0              | REV ID Number                      | 4     | 0x00                      | 0x00       | 0x00                      |                                                                                                                                                                                                  |
| Tx IAMP GAIN AND BIAS CONTROL                           |                  |                                    |       |                           |            |                           |                                                                                                                                                                                                  |
| 0x10                                                    | 7                | Select Tx Gain                     | 1     | 0x04                      | 0x04       | 0x04                      | N = 0, 1, 2, 3, 4.                                                                                                                                                                               |
|                                                         | 2:0              | N                                  | 3     | 0x04                      | 0x04       | 0x04                      |                                                                                                                                                                                                  |
| 0x12                                                    | 6:4              | Standing Current                   | 3     | 0x01                      | 0x01       | 0x01                      | Standing current.                                                                                                                                                                                |
|                                                         | 2:0              | I <sub>OFF1</sub> Standing Current | 3     | 0x01                      | 0x01       | 0x01                      |                                                                                                                                                                                                  |
| 0x13                                                    | 7:5              | CPGA Bias Adjust                   | 3     | 0x00                      | 0x00       | 0x00                      | Current bias setting for Rx path's functional blocks. Refer to the Power Reduction Options section.                                                                                              |
|                                                         | 4:3              | SPGA Bias Adjust                   | 2     |                           |            |                           |                                                                                                                                                                                                  |
|                                                         | 2:0              | ADC Bias Adjust                    | 4     |                           |            |                           |                                                                                                                                                                                                  |

<sup>1</sup> Bits that are undefined should always be assigned a 0.<sup>2</sup> Full-duplex only.

## REGISTER MAP DESCRIPTION

The AD9868 contains a set of programmable registers (see Table 10) that are used to optimize its numerous features, interface options, and performance parameters from its default register settings. Registers pertaining to similar functions have been grouped together and assigned adjacent addresses to minimize the update time when using the multibyte serial port interface (SPI) read/write feature. Bits that are undefined within a register should be assigned a 0 when writing to that register.

The default register settings are intended to allow some applications to operate without using an SPI. The AD9868 can be configured to support a half- or full-duplex digital interface via the MODE pin, with each interface having two possible default register settings determined by the setting of the CONFIG pin.

For instance, applications that need to use only the Tx or Rx path functionality can configure the AD9868 for a half-duplex interface (MODE = 0), and use the TXEN pin to select between the Tx or Rx signal path with the unused path remaining in a reduced power state. The CONFIG pin can be used to select the default interpolation ratio of the Tx path and RxPGA gain mapping.

## SERIAL PORT INTERFACE (SPI)

The serial port of the AD9868 has 3-wire or 4-wire SPI capability allowing read/write access to all registers that configure the device's internal parameters. Registers pertaining to the SPI are listed in Table 11. The default 3-wire serial communication port consists of a clock (SCLK), serial port enable ( $\overline{\text{SEN}}$ ), and a bidirectional data (SDIO) signal.  $\overline{\text{SEN}}$  is an active low, control gating, read and write cycle. When  $\overline{\text{SEN}}$  is high, SDO and SDIO are three-stated. The inputs to SCLK,  $\overline{\text{SEN}}$ , and SDIO contain a Schmitt trigger with a nominal hysteresis of 0.4 V centered about  $\text{DRVDD}/2$ . The SDO pin remains three-stated in a 3-wire SPI interface.

**Table 11. SPI Registers Pertaining to SPI Options**

| Address (Hex) | Bit | Description           |
|---------------|-----|-----------------------|
| 0x00          | 7   | Enable 4-wire SPI.    |
|               | 6   | Enable SPI LSB first. |

A 4-wire SPI can be enabled by setting the 4-wire SPI bit high, causing the output data to appear on the SDO pin instead of on the SDIO pin. The SDIO pin serves as an input-only throughout the read operation. Note that the SDO pin is active only during the transmission of data and remains three-stated at any other time.

An 8-bit instruction header must accompany each read and write operation. The instruction header is shown in Table 12. The MSB is an R/W indicator bit with logic high indicating a read operation. The next two bits, N1 and N0, specify the number of bytes (one to four bytes) to be transferred during the data transfer cycle. The remaining five bits specify the address bits to be accessed during the data transfer portion. The data bits immediately follow the instruction header for both read and write operations.

**Table 12. Instruction Header Information**

| MSB |    |    |    |    |    | LSB |    |
|-----|----|----|----|----|----|-----|----|
| 17  | 16 | 15 | 14 | 13 | 12 | 11  | 10 |
| R/W | N1 | N0 | A4 | A3 | A2 | A1  | A0 |

The AD9868 serial port can support both MSB (most significant bit) first and LSB (least significant bit) first data formats. Figure 3 illustrates how the serial port words are built for the MSB first and Figure 4 illustrates LSB first modes. The bit order is controlled by the SPI LSB first bit (Register 0x00, Bit 6). The default value is 0, MSB first. Multibyte data transfers in MSB format can be completed by writing an instruction byte that includes the register address of the last address to be accessed. The AD9868 automatically decrements the address for each successive byte required for the multibyte communication cycle.

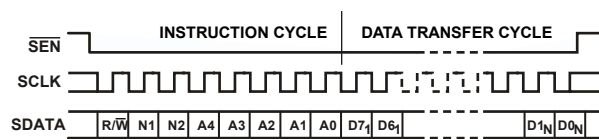


Figure 3. SPI Timing, MSB First

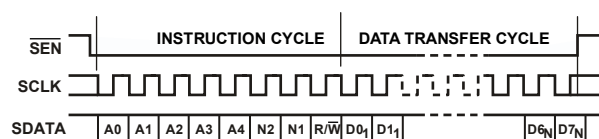


Figure 4. SPI Timing, LSB First

When the SPI LSB first bit is set high, the serial port interprets both instruction and data bytes LSB first. Multibyte data transfers in LSB format can be completed by writing an instruction byte that includes the register address of the first address to be accessed. The AD9868 automatically increments the address for each successive byte required for the multibyte communication cycle.

Figure 5 illustrates the timing requirements for a write operation to the SPI port. After the serial port enable ( $\overline{\text{SEN}}$ ) signal goes low, data (SDIO) pertaining to the instruction header is read on the rising edges of the clock (SCLK). To initiate a write operation, the read/not-write bit is set low. After the instruction header is read, the eight data bits pertaining to the specified register are shifted into the SDIO pin on the rising edge of the next eight clock cycles. If a multibyte communication cycle is specified, the destination address is decremented (MSB first) and shifts in another eight bits of data. This process repeats until all the bytes specified in the instruction header (N1 bit, N0 bit) are shifted into the SDIO pin.  $\overline{\text{SEN}}$  must remain low during the data transfer operation, only going high after the last bit is shifted into the SDIO pin.

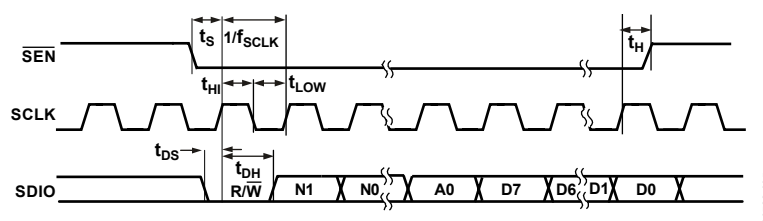


Figure 5. SPI Write Operation Timing

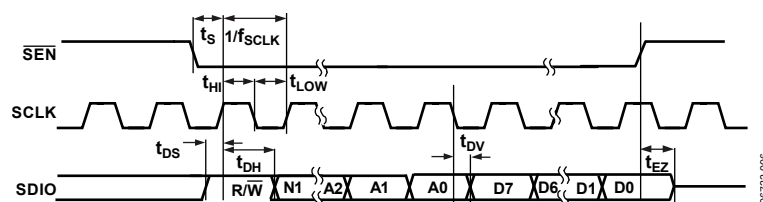


Figure 6. SPI 3-Wire Read Operation Timing

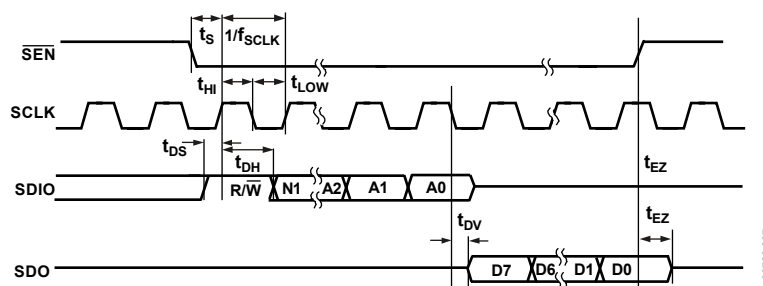


Figure 7. SPI 4-Wire Read Operation Timing

Figure 6 illustrates the timing for a 3-wire read operation to the SPI port. After  $\overline{\text{SEN}}$  goes low, data (SDIO) pertaining to the instruction header is read on the rising edges of SCLK. A read operation occurs if the read/not-write indicator is set high. After the address bits of the instruction header are read, the eight data bits pertaining to the specified register are shifted out of the SDIO pin on the falling edges of the next eight clock cycles. If a multibyte communication cycle is specified in the instruction header, a similar process as previously described for a multibyte SPI write operation applies. The SDO pin remains three-stated in a 3-wire read operation.

Figure 7 illustrates the timing for a 4-wire read operation to the SPI port. The timing is similar to the 3-wire read operation with the exception of the data appearing at the SDO pin, while the SDIO pin remains at high impedance throughout the operation. The SDO pin is an active output only during the data transfer phase and remains three-stated at all other times.

## DIGITAL INTERFACE

The digital interface port is configurable for half-duplex or full-duplex operation by pin strapping the MODE pin low or high, respectively. In half-duplex mode, the digital interface port becomes a 10-bit bidirectional bus called the ADIO port. In full-duplex mode, the digital interface port is divided into two 6-bit ports called Tx[5:0] and Rx[5:0] for simultaneous Tx and Rx operations. In this mode, data is transferred between the ASIC and AD9868 in 6-bit (or 5-bit) nibbles. The AD9868 also features a flexible digital interface for updating the RxPGA and TxPGA gain registers via a 6-bit PGA port or Tx[5:0] port for fast updates, or via the SPI port for slower updates. See the RxPGA Control section for more information.

### HALF-DUPLEX MODE

The half-duplex mode is selected when the MODE pin is tied low. In this mode, the bidirectional ADIO port is typically shared in burst fashion between the transmit path and receive path. Two control signals, TXEN and RXEN, from a DSP (or digital ASIC) control the bus direction by enabling the ADIO port's input latch and output driver, respectively. Two clock signals are also used, TXCLK to latch the Tx input data, and RXCLK to clock the Rx output data. The ADIO port can be disabled by setting TXEN and RXEN low (default setting), thus allowing it to be connected to a shared bus.

Internally, the ADIO port consists of an input latch for the Tx path in parallel with an output latch with three-state outputs for the Rx path. TXEN is used to enable the input latch; RXEN is used to three-state the output latch. A five-sample-deep FIFO is used on the Tx and Rx paths to absorb any phase difference between the AD9868 internal clocks and the externally supplied clocks (TXCLK, RXCLK). The ADIO bus accepts input data-words into the transmit path when the TXEN pin is high, the RXEN pin is low, and a clock is present on the TXCLK pin, as shown in Figure 8.

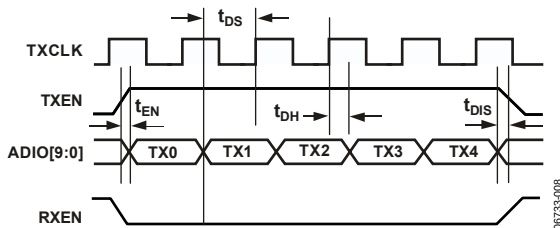


Figure 8. Transmit Data Input Timing Diagram

The Tx interpolation filter(s) following the ADIO port can be flushed with zeros if the clock signal into the TXCLK pin is present for 33 clock cycles after TXEN goes low. Note that the data on the ADIO bus is irrelevant over this interval.

The output from the receive path is driven onto the ADIO bus when the RXEN pin is high and when a clock is present on the RXCLK pin. While the output latch is enabled by RXEN, valid data appears on the bus after a 6-clock-cycle delay due to the internal FIFO delay. Note that Rx data is not latched back into the Tx path if TXEN is high during this interval with TXCLK present. The ADIO bus becomes three-stated once the RXEN pin returns low. Figure 9 shows the receive path output timing.

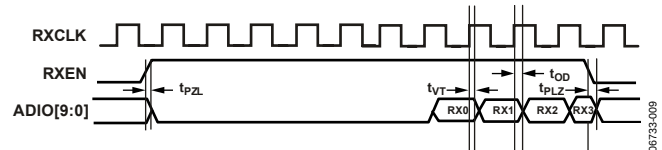


Figure 9. Receive Data Output Timing Diagram

To add flexibility to the digital interface port, several programming options are available in the SPI registers. These options are listed in Table 13. The default Tx and Rx data input formats are straight binary, but can be changed to twos complement. The default TXEN and RXEN settings are active high, but can be set to opposite polarities, thus allowing them to share the same control. In this case, the ADIO port can still be placed onto a shared bus by disabling its input latch via the control signal, and disabling the output driver via the SPI register. The clock timing can be independently changed on the transmit and receive paths by selecting either the rising or falling clock edge as the validating/sampling edge of the clock. Lastly, the output driver strength can be reduced for lower data rate applications.

Table 13. SPI Registers for Half-Duplex Interface

| Address (Hex) | Bit | Description                 |
|---------------|-----|-----------------------------|
| 0x0C          | 4   | Invert TXEN.                |
|               | 1   | TXCLK negative edge.        |
|               | 0   | Twos complement.            |
| 0x0D          | 5   | Rx port three-state.        |
|               | 4   | Invert RXEN.                |
|               | 1   | RXCLK negative edge.        |
|               | 0   | Twos complement.            |
| 0x0E          | 7   | Low digital drive strength. |

The half-duplex interface can be configured to act as a slave or a master to the digital ASIC. An example of a slave configuration is shown in Figure 10. In this example, the AD9868 accepts all the clock and control signals from the digital ASIC. Because the sampling clocks for the DAC and ADC are derived internally from the OSCIN signal, the TXCLK and RXCLK signals must be at exactly the same frequency as the OSCIN signal. The phase relationships among the TXCLK, RXCLK, and OSCIN signals can be arbitrary. If the digital ASIC cannot provide a low jitter clock source to OSCIN, use the AD9868 to generate the clock for its DAC and ADC and to pass the desired clock signal to the digital ASIC via CLKOUT1 or CLKOUT2.



Figure 11 shows a half-duplex interface with the AD9868 acting as the master, generating all the required clocks. CLKOUT1 provides a clock equal to the bus data rate that is fed to the ASIC as well as back to the TXCLK and RXCLK inputs. This interface has the advantage of reducing the digital ASIC pin count by three. The ASIC needs only to generate a bus control signal that controls the data flow on the bidirectional bus.



## FULL-DUPLEX MODE

In either application, Tx data and Rx data are transferred between the ASIC and AD9868 in 6-bit (or 5-bit) nibbles at twice the internal input/output word rates of the Tx interpolation filter and ADC. Note that the TxDAC update rate must not be less than the nibble rate. Therefore, the  $2\times$  or  $4\times$  interpolation filter must be used with a full-duplex interface.

The AD9868 acts as the master, providing RXCLK as an output clock that is used for the timing of both the Tx[5:0] and Rx[5:0] ports. RXCLK always runs at the nibble rate and can be inverted or disabled via an SPI register. Because RXCLK is derived from the clock synthesizer, it remains active provided that this functional block remains powered on. A buffered version of the signal appearing at OSCIN can also be directed to RXCLK by setting Bit 2 of Register 0x05. This feature allows the AD9868 to be completely powered down (including the clock synthesizer) while serving as the master.

The Tx[5:0] port operates in the following manner with the SPI register default settings:

1. Two consecutive nibbles of the Tx data are multiplexed together to form a 10-bit data-word in two's complement format.
2. The clock appearing on the RXCLK pin is a buffered version of the internal clock used by the Tx[5:0] port's input latch with a frequency that is always twice the ADC sample rate ( $2 \times f_{\text{ADC}}$ ).
3. Data from the Tx[5:0] port is read on the rising edge of this sampling clock, as illustrated in the timing diagram shown in Figure 12. Note that  $\overline{\text{TXQUIET}}$  must remain high for the reconstructed Tx data to appear as an analog signal at the output of the TxDAC or IAMP.
4. The TXSYNC signal is used to indicate which word belongs to which nibble. While TXSYNC is low, the first nibble of every word is read as the most significant nibble. The second nibble of that same word is read on the following TXSYNC high level as the least significant nibble. If TXSYNC is low for more than one clock cycle, the last transmit data is read continuously until TXSYNC is brought high for the second nibble of a new transmit word. This feature can be used to flush the interpolator filters with zeros. Note that the GAIN signal must be kept low during a Tx operation.



Figure 12. Tx[5:0] Port Full-Duplex Timing Diagram

The Rx[5:0] port operates in the following manner with the SPI register default settings:

1. Two consecutive nibbles of the Rx data are multiplexed together to form a 10-bit data-word in twos complement format.
2. The Rx data is valid on the rising edge of RXCLK, as illustrated in the timing diagram shown in Figure 13.
3. The RXSYNC signal is used to indicate which word belongs to which nibble. While RXSYNC is low, the first nibble of every word is transmitted as the most significant nibble. The second nibble of that same word is transmitted on the following RXSYNC high level as the least significant nibble.

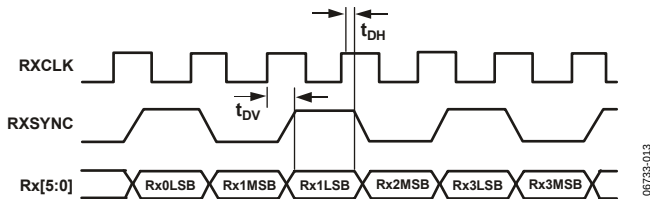


Figure 13. Full-Duplex Rx Port Timing

To add flexibility to the full-duplex digital interface port, several programming options are available in the SPI registers. These options are listed in Table 14. The timing for the Tx[5:0] and/or Rx[5:0] ports can be independently changed by selecting either the rising or falling clock edge as the sampling/validating edge of the clock. Inverting RXCLK (via Bit 1 of Register 0x05) affects both the Rx and Tx interface because they both use RXCLK.

Table 14. SPI Registers for Full-Duplex Interface

| Address (Hex) | Bit | Description                 |
|---------------|-----|-----------------------------|
| 0x05          | 2   | OSCIN to RXCLK.             |
|               | 1   | Invert RXCLK.               |
|               | 0   | Disable RXCLK.              |
| 0x0B          | 2   | Rx gain on Tx port.         |
| 0x0C          | 4   | Invert TXSYNC.              |
|               | 3   | Tx 5/5 nibble.              |
|               | 2   | LS nibble first.            |
|               | 1   | TXCLK negative edge.        |
|               | 0   | Twos complement.            |
| 0x0D          | 5   | Rx port three-state.        |
|               | 4   | Invert RXSYNC.              |
|               | 3   | Rx 5/5 nibble.              |
|               | 2   | LS nibble first.            |
|               | 1   | RXCLK negative edge.        |
|               | 0   | Twos complement.            |
| 0x0E          | 7   | Low digital drive strength. |

The default Tx and Rx data input formats are twos complement, but can be changed to straight binary. The default TXSYNC and RXSYNC settings can be changed such that the first nibble of the word appears while either TXSYNC, RXSYNC, or both are high. In addition, the least significant nibble can be selected as the first nibble of the word (least significant nibble first). The output driver strength can also be reduced for lower data rate applications.

For the AD9868, the most significant nibble defaults to 6 bits, and the least significant nibble defaults to 4 bits. This can be changed so that the least significant nibble and most significant nibble have 5 bits each. To accomplish this, set the 5/5 nibble bit (Bit 3 in Register 0x0C and Bit 3 in Register 0x0D), and use the Tx[5:1] and Rx[5:1] data pins.

Figure 14 shows a possible digital interface between an ASIC and the AD9868. The AD9868 serves as the master generating the required clocks for the ASIC. This interface requires that the ASIC reserve 16 pins for the interface, assuming a 6-bit nibble width and the use of the Tx port for RxPGA gain control. Note that the ASIC pin allocation can be reduced by 3 if a 5-bit nibble width is used and the gain (or gain strobe) of the RxPGA is controlled via the SPI port.

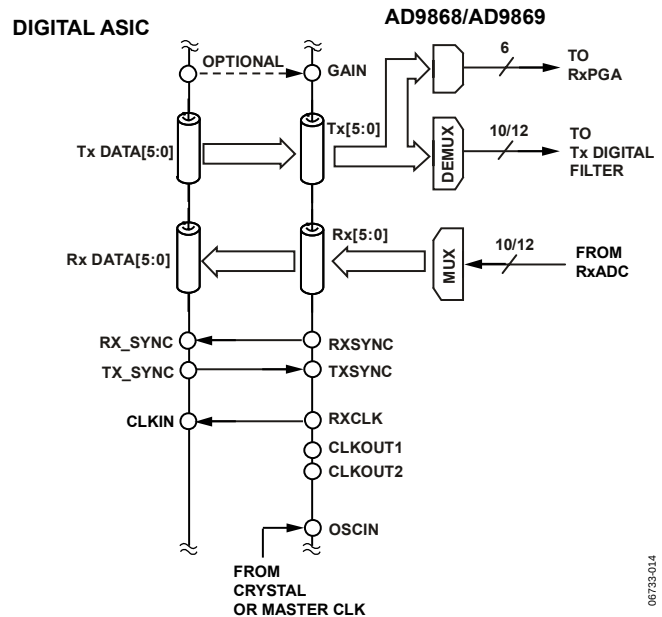


Figure 14. Example of a Full-Duplex Digital Interface with Optional RxPGA Gain Control via Tx[5:0]

## RxPGA CONTROL

The AD9868 contains a digital PGA in the Rx path that is used to extend the dynamic range. The RxPGA can be programmed over  $-12$  dB to  $+48$  dB with 1 dB resolution using a 6-bit word, and with a 0 dB setting corresponding to a 2 V p-p input signal. The 6-bit word is fed into a look-up table (LUT) that is used to distribute the desired gain over three amplification stages within the Rx path. Upon power-up, the RxPGA gain register is set to its minimum gain of  $-12$  dB. The RxPGA gain mapping is shown in Figure 15.

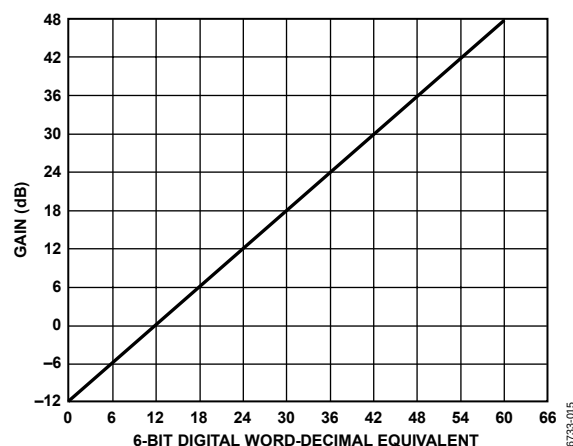


Figure 15. Digital Gain Mapping of RxPGA

Table 15 lists the SPI registers pertaining to the RxPGA.

Table 15. SPI Registers for RxPGA Control

| Address (Hex) | Bit | Description                                   |
|---------------|-----|-----------------------------------------------|
| 0x09          | 6   | Enable RxPGA update via SPI.                  |
|               | 5:0 | RxPGA gain code.                              |
| 0x0B          | 6   | Select TxPGA via PGA[5:0].                    |
|               | 5   | Select RxPGA via PGA[5:0].                    |
|               | 3   | Enable software gain strobe, full-duplex.     |
|               | 2   | Enable RxPGA update via Tx[5:0], full-duplex. |
|               | 1   | 3-Bit RxPGA gain mapping, half-duplex.        |

The RxPGA gain register can be updated via the Tx[5:0] port, the PGA[5:0] port, or the SPI port. The first two methods allow fast updates of the RxPGA gain register and should be considered for digital AGC functions requiring a fast closed-loop response. The SPI port allows direct update and readback of the RxPGA gain register via Register 0x09 with an update rate limited to 1.6 MSPS (with SCLK = 32 MHz). Note that Bit 6 of Register 0x09 must be set for a read or write operation.

Updating the RxPGA via the Tx[5:0] port is an option only in full-duplex mode<sup>1</sup>. In this case, a high level on the GAIN pin<sup>2</sup> with TXSYNC low programs the PGA setting on either the rising edge or falling edge of RXCLK, as shown in Figure 16. The GAIN pin must be held high, TXSYNC must be held low, and gain data must be stable for one or more clock cycles to update the RxPGA gain setting.

A low level on the GAIN pin enables data to be fed to the digital interpolation filter. This interface should be considered when upgrading existing designs from the AD9875/AD9876 MxFE products or from half-duplex applications trying to minimize an ASIC pin count.

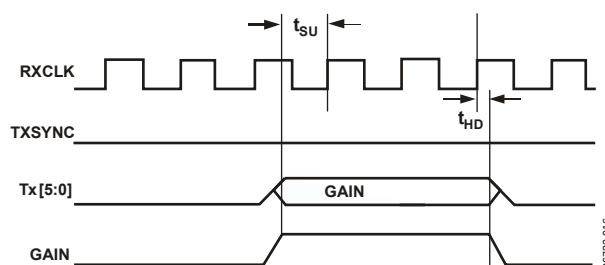


Figure 16. Updating RxPGA via Tx[5:0] in Full-Duplex Mode

Updating the RxPGA (or TxPGA) via the PGA[5:0] port is an option for both the half-duplex<sup>3</sup> and full-duplex interface. The PGA port consists of an input buffer that passes the 6-bit data appearing at its input directly to the RxPGA (or TxPGA) gain register with no gating signal required. Bit 5 or Bit 6 of Register 0x0B is used to select whether the data updates the RxPGA or TxPGA gain register. In applications that switch between RxPGA and TxPGA gain control via PGA[5:0], be sure that the RxPGA (or TxPGA) is not inadvertently loaded with the wrong data during a transition. In the case of an RxPGA-to-TxPGA transition, first deselect the RxPGA gain register, update the PGA[5:0] port with the desired TxPGA gain setting, and then select the TxPGA gain register.

Note that a silicon bug exists with the full-duplex interface (MODE = 1), which requires that the GAIN/PGA[5] pin remains low for the digital Tx path to remain enabled. Full-duplex protocol applications must use the SPI port to control the Tx and Rx gain. Half-duplex protocol applications using the function can use an AND gate with TXQUIET and the PGA5 bit serving as inputs to ensure that the GAIN/PGA[5] pin remains low during a Tx operation.

<sup>1</sup> Default setting for full-duplex mode (MODE = 1).

<sup>2</sup> The gain strobe can also be set in software via Register 0x0B, Bit 3 for continuous updating. This eliminates the requirement for the external gain signal, reducing the ASIC pin count by 1.

<sup>3</sup> Default setting for half-duplex mode (MODE = 0).

TxPGA CONTROL

The AD9868 also contains a digital PGA in the Tx path distributed between the TxDAC and IAMP. The TxPGA is used to control the peak current from the TxDAC and IAMP over a 7.5 dB and 19.5 dB span, respectively, with 0.5 dB resolution. A 6-bit word is used to set the TxPGA attenuation according to the mapping shown in Figure 17. The TxDAC gain mapping is applicable only when Bit 0 of Register 0x0E is set, and only when the 4 LSBs of the 6-bit gain word are relevant.

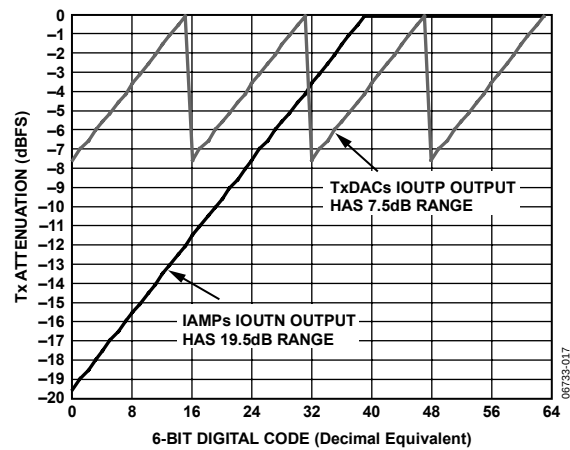


Figure 17. Digital Gain Mapping of TxPGA

The TxPGA register can be updated via the PGA[5:0] port or SPI port. The first method should be considered for fast updates of the TxPGA register. Its operation is similar to the description in the RxPGA Control section. The SPI port allows direct update and readback of the TxPGA register via Register 0x0A with an update rate limited to 1.6 MSPS (SCLK = 32 MHz). Bit 6 of Register 0x0A must be set for a read or write operation.

Table 16 lists the SPI registers pertaining to the TxPGA. The TxPGA control register default setting is for minimum attenuation (0 dBFS) with the PGA[5:0] port disabled for Tx gain control.

Table 16. SPI Registers TxPGA Control

| Address (Hex) | Bit | Description                   |
|---------------|-----|-------------------------------|
| 0x0A          | 6   | Enable TxPGA update via SPI.  |
|               | 5:0 | TxPGA gain code.              |
| 0x0B          | 6   | Select TxPGA via PGA[5:0].    |
|               | 5   | Select RxPGA via PGA[5:0].    |
| 0x0E          | 0   | TxDAC output (IAMP disabled). |

## TRANSMIT PATH

The transmit path of the AD9868 (or its related part, the AD9869) of a selectable digital  $2\times/4\times$  interpolation filter, a 10-bit (or 12-bit) TxDAC, and a current-output amplifier, IAMP (see Figure 18). Note that the additional two bits of resolution offered by the AD9869 result in a 10 dB to 12 dB reduction in the pass-band noise floor. The digital interpolation filter relaxes the Tx analog filtering requirements by simultaneously reducing the images from the DAC reconstruction process while increasing the analog filter's transition band. The digital interpolation filter can also be bypassed, resulting in lower digital current consumption.

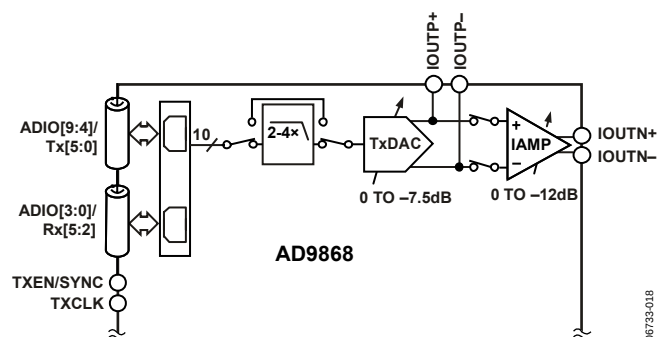


Figure 18. Functional Block Diagram of Tx Path

## DIGITAL INTERPOLATION FILTERS

The input data from the Tx port can be fed into a selectable  $2\times/4\times$  interpolation filter. The interpolation factor for the digital filter is set via SPI Register 0x0C with the settings shown in Table 17. The maximum input word rate,  $f_{DATA}$ , into the interpolation filter is 80 MSPS; the maximum DAC update rate is 200 MSPS. Therefore, applications with input word rates at or below 50 MSPS can benefit from  $4\times$  interpolation, whereas applications with input word rates between 50 MSPS and 80 MSPS can benefit from  $2\times$  interpolation.

Table 17. Interpolation Factor Set via SPI Register 0x0C

| Bits 7:6] | Interpolation Factor |
|-----------|----------------------|
| 00        | 4                    |
| 01        | 2                    |
| 10        | Do not use           |
| 11        | Do not use           |

The interpolation filter consists of two cascaded half-band filter stages with each stage providing  $2\times$  interpolation. The first stage filter consists of 43 taps. The second stage filter, operating at the higher data rate, consists of 11 taps. The normalized wideband and pass-band filter responses (relative  $f_{DATA}$ ) for the  $2\times$  low-pass interpolation filter and  $4\times$  low-pass interpolation filter are shown in Figure 19 and Figure 20, respectively.

These responses also include the inherent  $\text{sinc}(x)$  from the TxDAC reconstruction process and can be used to estimate any post analog filtering requirements.

The pipeline delays of the  $2\times$  and  $4\times$  filter responses are 21.5 clock cycles and 24 clock cycles, respectively, relative to  $f_{DATA}$ . The filter delay is also taken into consideration for applications configured for a half-duplex interface with the half-duplex power-down mode enabled. This feature allows the user to set a programmable delay that powers down the TxDAC and IAMP only after the last Tx input sample has propagated through the digital filter. See the Power Control and Dissipation section for more details.

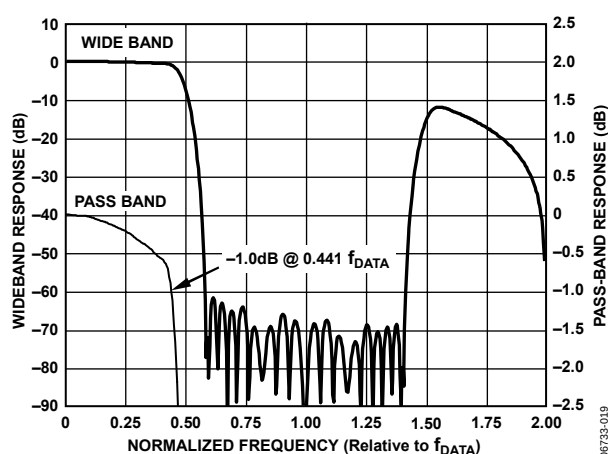


Figure 19. Frequency Response of  $2\times$  Interpolation Filter (Normalized to  $f_{DATA}$ )

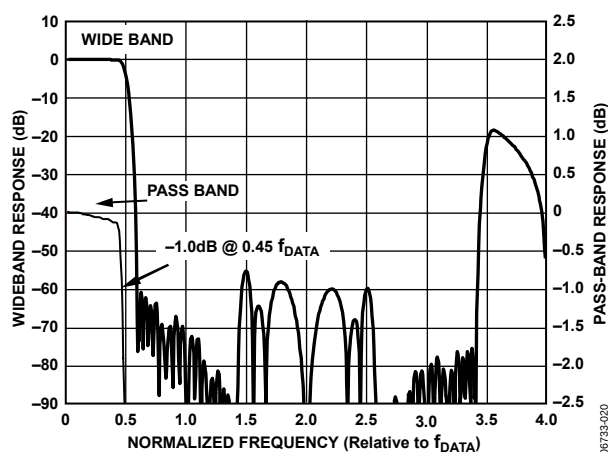


Figure 20. Frequency Response of  $4\times$  Interpolation Filter (Normalized to  $f_{DATA}$ )

## TxDAC AND IAMP ARCHITECTURE

The Tx path contains a TxDAC with a current amplifier, IAMP. The TxDAC reconstructs the output of the interpolation filter and sources a differential current output that can be directed to an external load or fed into the IAMP for further amplification. The TxDAC and IAMP peak current outputs are digitally programmable over a 0 dB to –7.5 dB and 0 dB to –19.5 dB range, respectively, in 0.5 dB increments. Note that this assumes default register settings for Register 0x10 and Register 0x11.

Applications demanding the highest spectral performance and/or lowest power consumption can use the TxDAC output directly. The TxDAC is capable of delivering a peak signal power-up to 10 dBm while maintaining respectable linearity performance. For power-sensitive applications requiring the highest Tx power efficiency, the TxDAC full-scale current output can be reduced to as low as 2 mA, and its load resistors sized to provide a suitable voltage swing that can be amplified by a low power, op amp-based driver.

Most applications requiring higher peak signal powers (up to 17 dBm) should use the IAMP. The IAMP can be configured as a current source for loads having a well-defined impedance (50  $\Omega$  or 75  $\Omega$  systems).

Figure 21 shows the equivalent schematic of the TxDAC and IAMP. The TxDAC provides a differential current output appearing at IOUTP+ and IOUTP–. The TxDAC can also be modeled as a differential current source generating a signal-dependent ac current, when  $\Delta I_s$  has a peak current of  $I$  along with two dc current sources, sourcing a standing current equal to  $I$ . The full-scale output current, IOUTP\_FS, is equal to the sum of these standing current sources (IOUTP\_FS =  $2 \times I$ ).

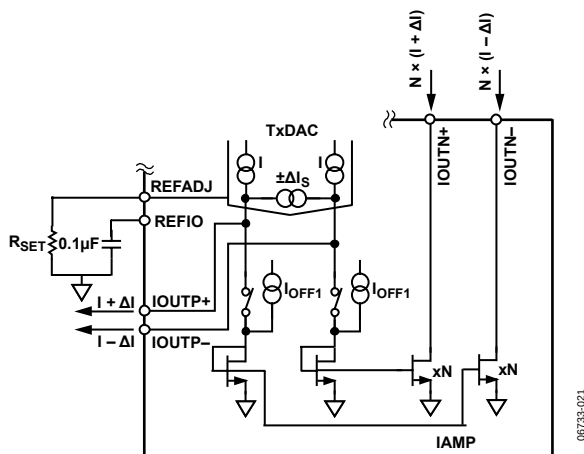


Figure 21. Equivalent Schematic of TxDAC and IAMP

The value of  $I$  is determined by the  $R_{SET}$  value at the REFADJ pin along with the Tx path's digital attenuation setting. With 0 dB attenuation, the value of  $I$  is

$$I = 16 \times (1.23/R_{SET}) \quad (1)$$

For example, an  $R_{SET}$  value of 1.96 k $\Omega$  results in  $I$  equal to 10.0 mA with IOUTP\_FS equal to 20.0 mA. Note that the REFIO pin provides a nominal band gap reference voltage of 1.23 V and should be decoupled to analog ground via a 0.1  $\mu$ F capacitor.

The differential current output of the TxDAC is always connected to the IOUTP pins, but it can be directed to the IAMP by clearing Bit 0 of Register 0x0E. As a result, the IOUTP pins must remain completely open if the IAMP is to be used. The IAMP consists of programmable current mirrors providing a gain factor of  $N$  that is programmable from 0 to 4 in steps of 1 (via Bits[2:0] of Register 0x10 with a default setting of  $N = 4$ ). Bit 7 of this register must be set to overwrite the default settings of this register. The maximum peak current per output is 100 mA and occurs when the TxDAC standing current,  $I$ , is set for 12.5 mA (IOUTP\_FS = 25 mA).

Because the current mirrors consist of NMOS devices, they sink current. Therefore, each output pin requires a dc current path to a positive supply. The voltage output of each output pin is allowed to swing between 0.5 V and 3.9 V. Lastly, both the standing current,  $I$ , and the ac current,  $\Delta I_s$ , from the TxDAC are amplified by the gain factor ( $N$ ) with the total standing current drawn from the positive supply being equal to

$$2 \times (N) \times I \quad (2)$$

Programmable current sources,  $I_{OFF1}$  via Register 0x12, can be used to improve the linearity performance under certain conditions by increasing their signal-to-standing current ratios. This feature provides a marginal improvement in distortion performance under large signal conditions when the peak ac current of the reconstructed waveform frequently approaches the dc standing current within the TxDAC (0 dBFS to –1 dBFS sine wave) causing the internal mirrors to turn off. However, the improvement in distortion performance diminishes as the crest factor (peak-to-rms ratio) of the ac signal increases. Most applications can disable these current sources (set to 0 mA via Register 0x12) to reduce the IAMP current consumption.

Table 18. SPI Registers for TxDAC and IAMP

| Address (Hex) | Bit | Description                                          |
|---------------|-----|------------------------------------------------------|
| 0x0E          | 0   | TxDAC output.                                        |
| 0x10          | 7   | Enable current mirror gain settings.                 |
|               | 2:0 | Primary path NMOS gain of 0 to 4 with $\Delta = 1$ . |
| 0x12          | 2:0 | $I_{OFF1}$ standing current.                         |

## Tx PROGRAMMABLE GAIN CONTROL



## LOW-PASS FILTER

The low-pass filter (LPF) provides a third-order response with a cutoff frequency that is typically programmable over a 15 MHz to 35 MHz span. The first real pole is implemented within the first CPGA gain stage (see Figure 24), and the complex pole pair is implemented in the second CPGA gain stage. Capacitor arrays are used to vary the different RC time constants within these two stages in a manner that changes the cutoff frequency while preserving the normalized frequency response. Because absolute resistor and capacitor values are process-dependent, a calibration routine lasting less than 100  $\mu$ s automatically occurs each time the target cutoff frequency register (Register 0x08) is updated, ensuring a repeatable cutoff frequency from device to device.

Although the default setting specifies that the LPF be active, it can also be bypassed providing a nominal  $f_{-3\text{ dB}}$  of 55 MHz. Table 19 shows the SPI registers pertaining to the LPF.

**Table 19. SPI Registers for Rx Low-Pass Filter**

| Address (Hex) | Bit | Description    |
|---------------|-----|----------------|
| 0x07          | 0   | Enable Rx LPF. |
| 0x08          | 7:0 | Target value.  |

The normalized wideband gain response is shown in Figure 26. The normalized pass-band gain and group delay responses are shown in Figure 27. The  $-3\text{ dB}$  cutoff frequency,  $f_{-3\text{ dB}}$ , results in  $-3\text{ dB}$  attenuation. In addition, the actual group delay time (GDT) response can be calculated given a programmed cutoff frequency using the following equation:

$$\text{Actual GDT} = \text{Normalized GDT} / (2.45 \times f_{-3\text{ dB}}) \quad (4)$$

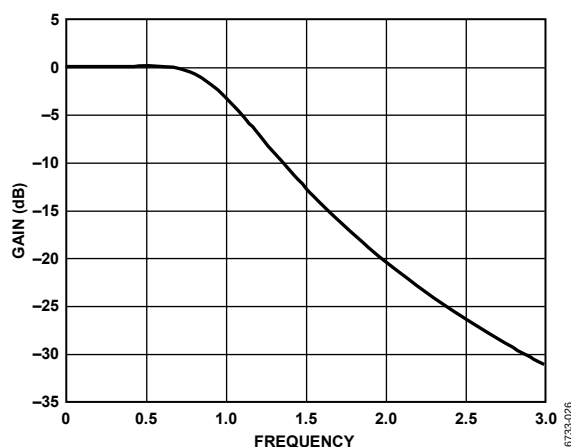


Figure 26. LPF Normalized Wideband Gain Response

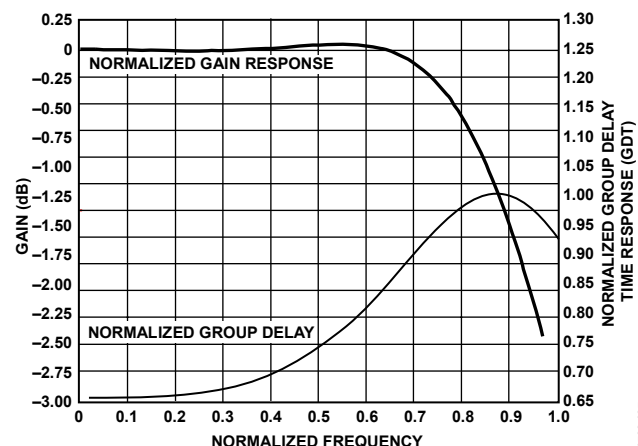


Figure 27. LPF Normalized Pass-Band Gain and Group Delay Responses

The  $f_{-3\text{ dB}}$  is programmable by writing an 8-bit word, referred to as the target, to Register 0x08. The cutoff frequency is a function of the ADC sample rate,  $f_{\text{ADC}}$ , and to a lesser extent, the RxPGA gain setting (in dB). Figure 28 shows how  $f_{-3\text{ dB}}$  varies as a function of the RxPGA gain setting.

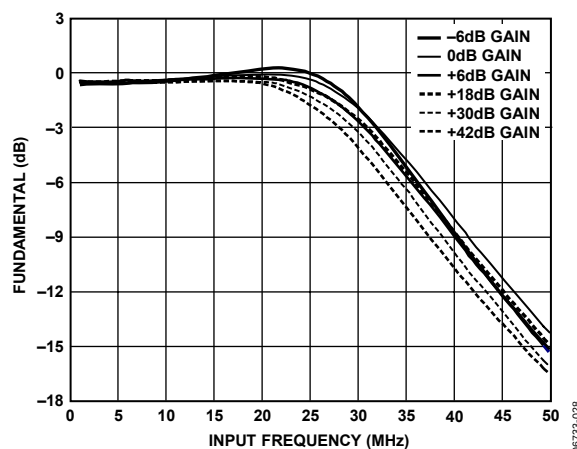


Figure 28. Effects of RxPGA Gain on LPF Frequency Response ( $f_{-3\text{ dB}} = 32\text{ MHz}$  @  $0\text{ dB}$  and  $f_{\text{ADC}} = 80\text{ MSPS}$ )

The following formula<sup>1</sup> can be used to estimate  $f_{-3\text{ dB}}$  for a RxPGA gain setting of  $0\text{ dB}$ :

$$f_{-3\text{ dB}, 0\text{ dB}} = (128/\text{target}) \times (f_{\text{ADC}}/80) \times (f_{\text{ADC}}/30 + 23.83) f \quad (5)$$

Figure 29 compares the measured and calculated  $f_{-3\text{ dB}}$  using this formula.

<sup>1</sup> Empirically derived for an  $f_{-3\text{ dB}}$  range of 15 MHz to 35 MHz and an  $f_{\text{ADC}}$  of 40 MSPS to 80 MSPS with an RxPGA =  $0\text{ dB}$ .

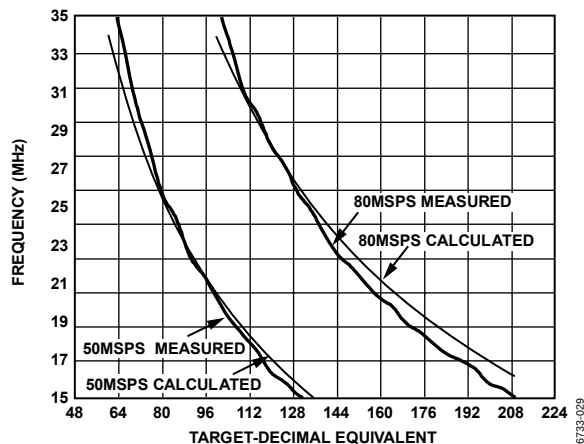


Figure 29. Measured and Calculated  $f_{-3\text{dB}}$  vs. Target Value for  $f_{\text{ADC}} = 50\text{ MSPS}$  and  $80\text{ MSPS}$

The following scaling factor can be applied to the previous formula to compensate for the RxPGA gain setting on  $f_{-3\text{dB}}$ :

$$\text{Scale Factor} = 1 - (\text{RxPGA in dB})/382 \quad (6)$$

This scaling factor reduces the calculated  $f_{-3\text{dB}}$  as the RxPGA increases. Applications that need to maintain a minimum cutoff frequency,  $f_{-3\text{dB\_MIN}}$ , for all RxPGA gain settings should first determine the scaling factor for the highest RxPGA gain setting to be used. Next, the  $f_{-3\text{dB\_MIN}}$  should be divided by this scale factor to normalize to the 0 dB RxPGA gain setting,  $f_{-3\text{dB\_0 dB}}$ . Equation 5 can then be used to calculate the target value.

The LPF frequency response shows a slight sensitivity to temperature, as shown in Figure 30. Applications sensitive to temperature drift can recalibrate the LPF by rewriting the target value to Register 0x08.

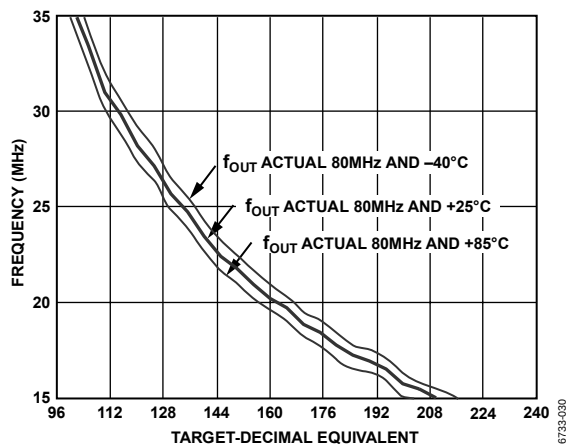


Figure 30.  $f_{-3\text{dB}}$  Temperature Drift for  $f_{\text{ADC}} = 80\text{ MSPS}$  and  $\text{RxPGA} = 0\text{ dB}$

## ANALOG-TO-DIGITAL CONVERTER (ADC)

The AD9868 features a 10-bit analog-to-digital converter (ADC) capable of up to 80 MSPS. As shown in Figure 24, the ADC is driven by the SPGA stage, which performs both the sample-and-hold and the fine gain adjust functions. A buffer amplifier (not shown) isolates the last CPGA gain stage from the dynamic load presented by the SPGA stage. The full-scale input span of the ADC is 2 V p-p, and depending on the PGA gain setting, the full-scale input span into the SPGA is adjustable from 1 V to 2 V in 1 dB increments.

A pipelined, multistage ADC architecture is used to achieve high sample rates while consuming low power. The ADC distributes the conversion over several smaller ADC subblocks, refining the conversion with progressively higher accuracy as it passes the results from stage to stage on each clock edge. The ADC typically performs best when driven internally by a 50% duty cycle clock.

The ADC power consumption can be reduced by 25 mA with minimal effect on its performance by setting Bit 4 of Register 0x07. Alternative power bias settings are also available via Register 0x13, as discussed in the Power Control and Dissipation section. Lastly, the ADC can be completely powered down for half-duplex operation, further reducing the peak power consumption of the AD9868.

The ADC has an internal voltage reference and reference amplifier as shown in Figure 31. The internal band gap reference generates a stable 1 V reference level that is converted to a differential 1 V reference centered about midsupply ( $\text{AVDD}/2$ ). The outputs of the differential reference amplifier are available at the REFT and REFB pins and must be properly decoupled for optimum performance. The REFT and REFB pins are conveniently situated at the corners of the LFCSP package such that C1 (0603 type) can be placed directly across its pins. C3 and C4 can be placed underneath C1, and C2 (10  $\mu\text{F}$  tantalum) can be placed furthest from the package.

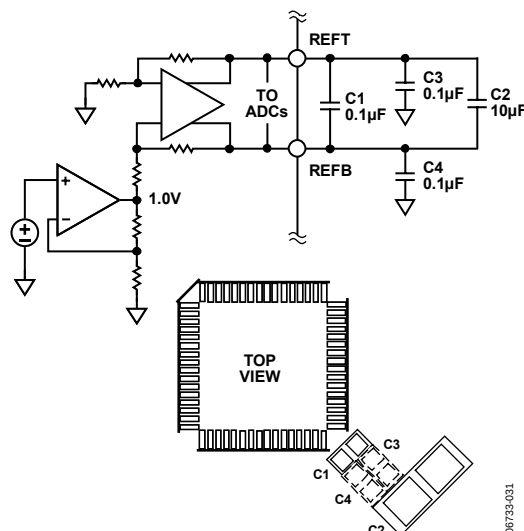


Figure 31. ADC Reference and Decoupling

Table 20 shows the SPI registers pertaining to the ADC.

**Table 20. SPI Registers for Rx ADC**

| Address (Hex) | Bit | Description            |
|---------------|-----|------------------------|
| 0x04          | 4   | ADC clock from PLL.    |
| 0x07          | 4   | ADC low power mode.    |
| 0x13          | 2:0 | ADC power bias adjust. |

## AGC TIMING CONSIDERATIONS

When implementing a digital AGC timing loop, it is important to consider the Rx path latency and settling time of the Rx path in response to a change in gain setting. While the RxPGA settling time may also show a slight dependency on the LPF cutoff frequency, the ADC pipeline delay, along with the ADIO bus interface, presents a more significant delay. The amount of delay or latency is dependent on whether a half-duplex or full-duplex is selected. An impulse response at the RxPGA input can be observed after 10.0 ADC clock cycles ( $1/f_{\text{ADC}}$ ) in the case of a half-duplex interface, and 10.5 ADC clock cycles in the case of a full-duplex interface. This latency, along with the RxPGA settling time, should be considered to ensure stability of the AGC loop.

## CLOCK SYNTHESIZER

The AD9868 generates all its internal sampling clocks, as well as two user-programmable clock outputs appearing at CLKOUT1 and CLKOUT2, from a single reference source (see Figure 32). The reference source can either be a fundamental frequency or an overtone quartz crystal connected between OSCIN and XTAL, with the parallel resonant load components specified by the crystal manufacturer. It can also be a TTL-level clock applied to OSCIN with XTAL left unconnected.

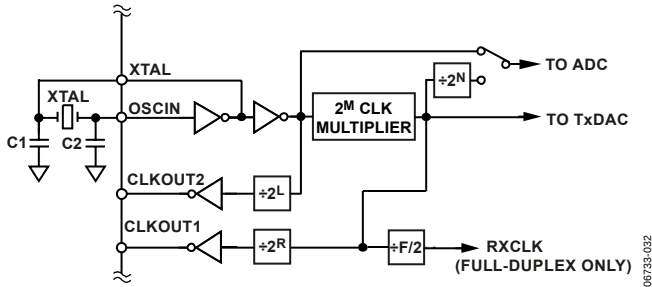


Figure 32. Clock Oscillator and Synthesizer

Special consideration should be given to the design of crystal oscillators using the AD9868 internal CMOS inverter. This is especially true when designing third overtone oscillators where crystal power dissipation and negative resistance upon start-up are a few of the issues to consider. For this reason, a 40 MHz or lower fundamental crystal is preferred with the AD9868.

The CMOS inverter device characteristics are listed in Table 21. It is recommended to consult with the selected crystal manufacturer to ensure that a robust design can be realized with the selected crystal and AD9868 CMOS inverter.

Table 21. CMOS Inverter Device Characteristics

| Parameter        | Nominal Value | Tolerance % | Description            |
|------------------|---------------|-------------|------------------------|
| RF               | 1.2 MΩ        | ±25         | Feedback resistor.     |
| gm               | 17 mA/V       | ±20         | At midsupply.          |
| Z <sub>OUT</sub> | 1.6 kΩ        | ±50         | At midsupply.          |
| C <sub>IN</sub>  | 2.5 pF        | ±25         | Parasitic capacitance. |
| C <sub>OUT</sub> | 2.0 pF        | ±25         | Parasitic capacitance. |

The data rate,  $f_{DATA}$ , for the Tx and Rx data paths must always be equal. Therefore, the ADC sample rate,  $f_{ADC}$ , is always equal to  $f_{DATA}$ , while the TxDAC update rate is a factor of 1, 2, or 4 of  $f_{DATA}$ , depending on the selected interpolation factor. The data rate refers to the word rate and should not be confused with the nibble rate in full-duplex interface.

The  $2^M$  CLK multiplier contains a PLL (with integrated loop filter) and a VCO capable of generating an output frequency that is a multiple of 1, 2, 4, or 8 of its input reference frequency,  $f_{OSCIN}$ , appearing at OSCIN. The input frequency range of  $f_{OSCIN}$  is between 20 MHz and 80 MHz, and the VCO can operate over an 80 MHz to 200 MHz span. For the best phase noise/jitter characteristics, it is advisable to operate the VCO with a

frequency between 100 MHz and 200 MHz. The VCO output drives the TxDAC directly such that its update rate,  $f_{DAC}$ , is related to  $f_{OSCIN}$  by the following equation:

$$f_{DAC} = 2^M \times f_{OSCIN} \quad (7)$$

where  $M = 0, 1, 2$ , or  $3$ .

$M$  is the PLL multiplication factor set in Register 0x04. The value of  $M$  is determined by the Tx path's word rate,  $f_{DATA}$ , and digital interpolation factor,  $F$ , as shown in the following equation:

$$M = \log_2(F \times f_{DATA}/f_{OSCIN}) \quad (8)$$

Note that if the reference frequency appearing at OSCIN is chosen to be equal to the Tx path and Rx path word rates,  $M$  is equal to  $\log_2(F)$ . Also note that the RXCLK frequency for full-duplex mode ( $MODE = 1$ ) is a function of the  $2^M$  CLK multiplier setting, as well as the interpolation factor,  $F$ . Full-duplex mode requires that RXCLK be equal to  $2 \times f_{DATA}$  because data is transferred in nibbles.

The clock source for the ADC can be selected in Register 0x04 as a buffered version of the reference frequency appearing at OSCIN (default setting) or a divided version of the VCO output,  $f_{DAC}$ . The first option is the default setting and most desirable if  $f_{OSCIN}$  is equal to  $f_{DAC}$ . This option typically results in the best jitter/phase noise performance for the ADC sampling clock. The second option is suitable in cases where  $f_{OSCIN}$  is a factor of 2 or 4 less than the  $f_{DAC}$ . In this case, the divider ratio,  $N$ , is chosen such that the divided down VCO output is equal to the ADC sample rate, as shown in the following equation:

$$f_{ADC} = f_{DAC}/2^N \quad (9)$$

where  $N = 0, 1$ , or  $2$ .

The CLK synthesizer also has two clock outputs appearing at CLKOUT1 and CLKOUT2. They are programmable via Register 0x06. Both outputs can be inverted or disabled. The voltage levels appearing at these outputs are relative to DRVDD and remain active during a hardware or software reset. Table 22 shows the SPI registers pertaining to the CLK synthesizer.

Table 22. SPI Registers for CLK Synthesizer

| Address (Hex) | Bit | Description                        |
|---------------|-----|------------------------------------|
| 0x04          | 4   | ADC CLK from PLL.                  |
|               | 3:2 | PLL divide factor ( $N$ ).         |
|               | 1:0 | PLL multiplication factor ( $M$ ). |
| 0x06          | 7:6 | CLKOUT2 divide number.             |
|               | 5   | CLKOUT2 invert.                    |
|               | 4   | CLKOUT2 disable.                   |
|               | 3:2 | CLKOUT1 divide number.             |
|               | 1   | CLKOUT1 invert.                    |
|               | 0   | CLKOUT1 disable.                   |

CLKOUT1 is a divided version of the VCO output and can be set to be a submultiple integer of  $f_{DAC}$  ( $f_{DAC}/2^R$ , where  $R = 0, 1, 2$ , or  $3$ ). Because this clock is derived from the same set of dividers used within the PLL core, it is phase-locked to the dividers such that its phase relationship relative to the signal appearing at OSCIN (or RXCLK) can be determined upon power-up. In addition, this clock has a near 50% duty cycle because it is derived from the VCO. As a result, CLKOUT1 should be selected before CLKOUT2 as the primary source for system clock distribution.

CLKOUT2 is a divided version of the reference frequency,  $f_{OSCIN}$ , and can be set to be a submultiple integer of  $f_{OSCIN}$  ( $f_{OSCIN}/2^L$ , where  $L = 0, 1$ , or  $2$ ). With  $L$  set to  $0$ , the output of CLKOUT2 is a delayed version of the signal appearing at OSCIN, exhibiting the same duty cycle characteristics. With  $L$  set to  $1$  or  $2$ , the output of CLKOUT2 is a divided version of the OSCIN signal, exhibiting a near 50% duty cycle, but without having a deterministic phase relationship relative to CLKOUT1 (or RXCLK).

## POWER CONTROL AND DISSIPATION

### POWER-DOWN

The AD9868 provides the ability to control the power-on state of various functional blocks. The state of the PWRDWN pin, along with the contents of Register 0x01 and Register 0x02, allow two user-defined power settings that are pin-selectable. The default settings<sup>1</sup> are such that Register 0x01 has all blocks powered on (all bits 0), while Register 0x02 has all blocks powered down (excluding the PLL) such that the clock signal remains available at CLKOUT1 and CLKOUT2. When the PWRDWN pin is low, the functional blocks corresponding to the bits in Register 0x01 are powered down. When the PWRDWN is high, the functional blocks corresponding to the bits in Register 0x02 are powered down. PWRDWN immediately affects the designated functional blocks with minimum digital delay.

**Table 23. SPI Registers Associated with Power-Down and Half-Duplex Power Savings**

| Address (Hex) | Bit | Description        | Comments                                                                           |
|---------------|-----|--------------------|------------------------------------------------------------------------------------|
| 0x01          | 7   | CLK Synthesizer    | PWRDWN = 0.<br>Default setting is all functional blocks powered on.                |
|               | 6   | TxDAC/IAMP         |                                                                                    |
|               | 5   | Tx Digital         |                                                                                    |
|               | 4   | REF                |                                                                                    |
|               | 3   | ADC CML            |                                                                                    |
|               | 2   | ADC                |                                                                                    |
|               | 1   | PGA Bias           |                                                                                    |
|               | 0   | RxPGA              |                                                                                    |
| 0x02          | 7   | CLK Synthesizer    | PWRDWN = 1.<br>Default setting is all functional blocks powered off excluding PLL. |
|               | 6   | TxDAC/IAMP         |                                                                                    |
|               | 5   | Tx Digital         |                                                                                    |
|               | 4   | REF                |                                                                                    |
|               | 3   | ADC CML            |                                                                                    |
|               | 2   | ADC                |                                                                                    |
|               | 1   | PGA Bias           |                                                                                    |
|               | 0   | RxPGA              |                                                                                    |
| 0x03          | 7:3 | Tx OFF Delay       | Half-duplex power savings.                                                         |
|               | 2   | Rx PWRDWN via TXEN |                                                                                    |
|               | 1   | Enable Tx PWRDWN   |                                                                                    |
|               | 0   | Enable Rx PWRDWN   |                                                                                    |

<sup>1</sup> With MODE = 1 and CONFIG = 1, Register 0x02 default settings are with all blocks powered off, with RXCLK providing a buffered version of the signal appearing at OSCIN. This setting results in the lowest power consumption upon power-up, while still allowing AD9868 to generate the system clock via a crystal.

### HALF-DUPLEX POWER SAVINGS

Significant power savings can be realized in applications having a half-duplex protocol, allowing only the Rx path or Tx path to be operational at one time. The power-savings method depends on whether the AD9868 is configured for a full-duplex or half-duplex interface. Functional blocks having fast power-on/power-off times for the Tx path and Rx path are controlled by the following bits: TxDAC/IAMP, Tx Digital, ADC, and RxPGA (see Table 23).

In the case of a full-duplex digital interface (MODE = 1), users can set Register 0x01 to Register 0x60 and Register 0x02 to Register 0x05 (or vice versa) such that the Tx path and Rx path are never powered on simultaneously. The PWRDWN pin can then be used to control which path is powered on, depending on the burst type. During a Tx burst, the Rx path PGA and ADC blocks can typically be powered down within 100 ns, while the Tx path DAC, IAMP, and digital filter blocks are powered up within 0.5  $\mu$ s. For an Rx burst, the Tx circuitry can be powered down within 100 ns, while the Rx circuitry is powered up within 2  $\mu$ s.

Setting the  $\overline{\text{TXQUIET}}$  pin low allows it to be used with the full-duplex interface to quickly power down the IAMP and disable the interpolation filter. This is meant to maintain backward compatibility with the AD9875/AD9876 MxFEs, except that the TxDAC remains powered if its IOUTP outputs are used. In most applications, the interpolation filter needs to be flushed with 0s before or after being powered down. This ensures that upon power-up, the TxDAC (and IAMP) have a negligible differential dc offset, thus preventing spectral splatter due to an impulse transient.

Applications using a half-duplex interface (MODE = 0) can benefit from an additional power-savings feature available in Register 0x03. This register is effective only for a half-duplex interface. In addition to providing power savings for half-duplex applications, this feature allows the AD9868 to be used in applications that need only its Rx (or Tx) path functionality through pin strapping, making a serial port interface (SPI) optional. This feature also allows the PWRDWN pin to retain its default function as a master power control, as defined in Table 10.

The default settings for Register 0x03 provide fast power control of the functional blocks in the Tx signal path and Rx signal path (outlined previously) using the TXEN pin. The TxDAC remains powered on in this mode, while the IAMP is powered down. Significant current savings are typically realized when the IAMP is powered down.

For a Tx burst, the falling edge of TXEN is used to generate an internal delayed signal for powering down the Tx circuitry. Upon receipt of this signal, power-down of the Tx circuitry occurs within 100 ns. The user-programmable delay for the Tx path power-down is meant to match the pipeline delay of the last Tx burst sample such that power-down of the TxDAC and IAMP does not impact its transmission. A 5-bit field in Register 0x03 sets the delay from 0 to 31 TXCLK clock cycles, with the default being 31 (0.62  $\mu$ s with  $f_{TXCLK} = 50$  MSPS). The digital interpolation filter is automatically flushed with midscale samples prior to power-down if the clock signal into the TXCLK pin is present for 33 additional clock cycles after TXEN returns low. For an Rx burst, the rising edge of TXEN is used to generate an internal signal (with no delay) that powers up the Tx circuitry within 0.5  $\mu$ s.

The Rx path power-on/power-off can be controlled by either TXEN or RXEN by setting Bit 2 of Register 0x03. In the default setting, the falling edge of TXEN powers up the Rx circuitry within 2  $\mu$ s, while the rising edge of TXEN powers down the Rx circuitry within 0.5  $\mu$ s. If RXEN is selected as the control signal, its rising edge powers up the Rx circuitry, and the falling edge powers it down. To disable the fast power-down of the Tx circuitry and/or Rx circuitry, set Bit 1 and/or Bit 0 to 0.

## POWER REDUCTION OPTIONS

The power consumption of the AD9868 can be significantly reduced from its default setting by optimizing the power consumption vs. performance of the various functional blocks in the Tx signal path and Rx signal path. On the Tx path, minimum power consumption is realized when the TxDAC output is used directly and its standing current is reduced to as low as 1 mA. Although a slight degradation in THD performance results at reduced standing currents, it often remains adequate for most applications because the op amp driver typically limits the overall linearity performance of the Tx path. The load resistors used at the TxDAC outputs (IOU<sub>TP</sub><sup>+</sup> and IOU<sub>TP</sub><sup>-</sup>) can be increased to generate an adequate differential voltage that can be further amplified via a power efficient op amp-based driver solution. Figure 33 shows how the supply current for the TxDAC is reduced from 55 mA to 14 mA as the standing current is reduced from 12.5 mA to 1.25 mA. Further Tx power savings can be achieved by bypassing or reducing the interpolation factor of the digital filter as shown in Figure 34.

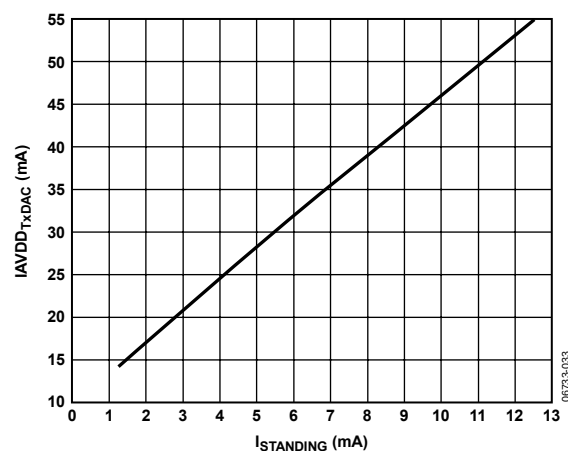


Figure 33. Reduction in TxDAC Supply Current vs. Standing Current

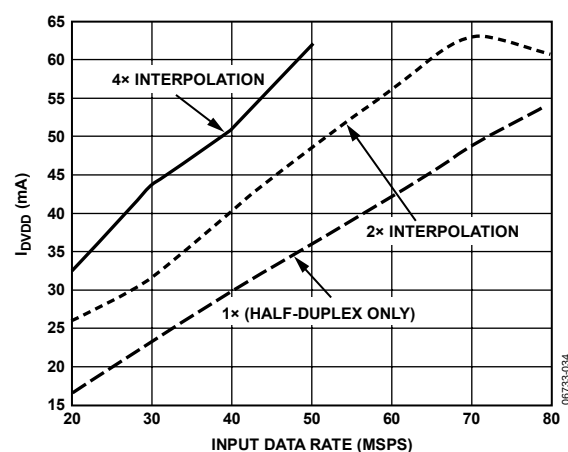


Figure 34. Digital Supply Current Consumption vs. Input Data Rate ( $DVDD = DRVDD = 3.3$  V and  $f_{OUT} = f_{DATA}/10$ )

Power consumption on the Rx path can be achieved by reducing the bias levels of the various amplifiers contained within the RxPGA and ADC. As previously noted, the RxPGA consists of two CPGA amplifiers and one SPGA amplifier. The bias levels of each of these amplifiers, along with the ADC, can be controlled via Register 0x13 as shown in Table 24. The default setting for Register 0x13 is 0x00.

Table 24. SPI Register for RxPGA and ADC Biasing

| Address (Hex) | Bit | Description            |
|---------------|-----|------------------------|
| 0x07          | 4   | ADC low power.         |
| 0x13          | 7:5 | CPGA bias adjust.      |
|               | 4:3 | SPGA bias adjust.      |
|               | 2:0 | ADC power bias adjust. |

Because the CPGA processes signals in the continuous time domain, its performance vs. bias setting remains mostly independent of the sample rate. Table 25 shows how the typical current consumption seen at AVDD varies as a function of Register 0x13, Bits [7:5], while the remaining bits are maintained at their default settings of 0. Only four of the possible settings result in any reduction in current consumption relative to the default setting. Reducing the bias level typically results in degradation in the THD vs. frequency performance as shown in Figure 35. This is due to a reduction of the amplifier's unity gain bandwidth, while the SNR performance remains relatively unaffected.

**Table 25. Analog Supply Current vs. CPGA Bias Settings at  $f_{ADC} = 65$  MSPS**

| Bit 7 | Bit 6 | Bit 5 | $\Delta mA$ |
|-------|-------|-------|-------------|
| 0     | 0     | 0     | 0           |
| 0     | 0     | 1     | -27         |
| 0     | 1     | 0     | -42         |
| 0     | 1     | 1     | -51         |
| 1     | 0     | 0     | -55         |
| 1     | 0     | 1     | +27         |
| 1     | 1     | 0     | +69         |
| 1     | 1     | 1     | +27         |

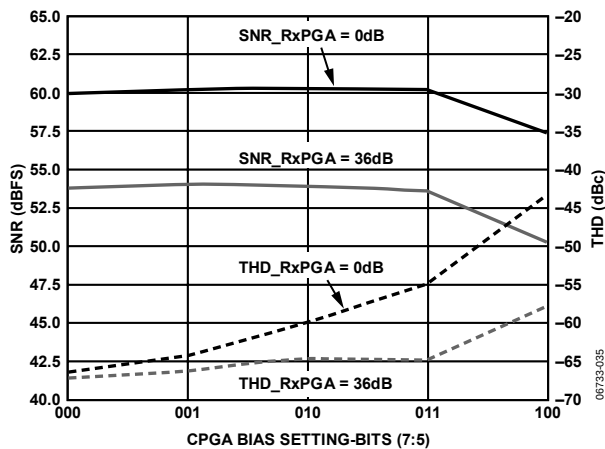


Figure 35. THD vs.  $f_{IN}$  Performance and CPGA Bias Settings (000, 001, 010, 100 with RxPGA = 0 and +36 dB, AIN = -1 dBFS, LPF set to 26 MHz,  $f_{ADC} = 50$  MSPS)

The SPGA is implemented as a switched capacitor amplifier, therefore, its performance vs. bias level is mostly dependent on the sample rate. Figure 36 shows how the typical current consumption seen at AVDD varies as a function of Register 0x13, Bits [4:3] and sample rate, while the remaining bits are maintained at the default setting of 0. Figure 37 shows how the SNR and THD performance is affected for a 10 MHz sine wave input as the ADC sample rate is swept from 20 MHz to 80 MHz. The SNR and THD performance remains relatively stable, suggesting that the SPGA bias can often be reduced from its default setting without impacting the device's overall performance.

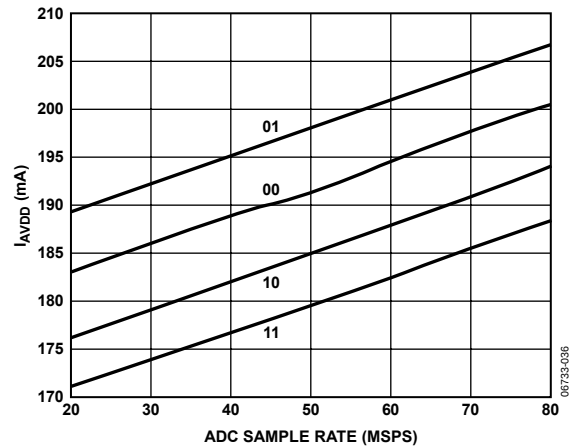


Figure 36. AVDD Current vs. SPGA Bias Setting and Sample Rate

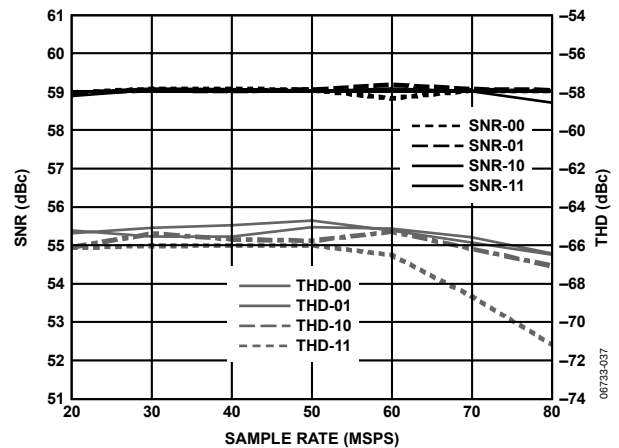


Figure 37. SNR and THD Performance vs.  $f_{ADC}$  and SPGA Bias Setting with RxPGA = 0 dB,  $f_{IN} = 10$  MHz, LPF set to 26 MHz, AIN = -1 dBFS

The ADC is based on a pipeline architecture with each stage consisting of a switched capacitor amplifier. Therefore, its performance vs. bias level is mostly dependent on the sample rate. Figure 38 shows how the typical current consumption seen at AVDD varies as a function of Register 0x13, Bits [2:0] and sample rate, while the remaining bits are maintained at the default setting of 0. Setting Bit 4 or Register 0x07 corresponds to the 011 setting, and the settings of 101 and 111 result in higher current consumption. Figure 39 shows how the SNR and THD performance are affected for a 10 MHz sine wave input for the lower power settings as the ADC sample rate is swept from 20 MHz to 80 MHz.

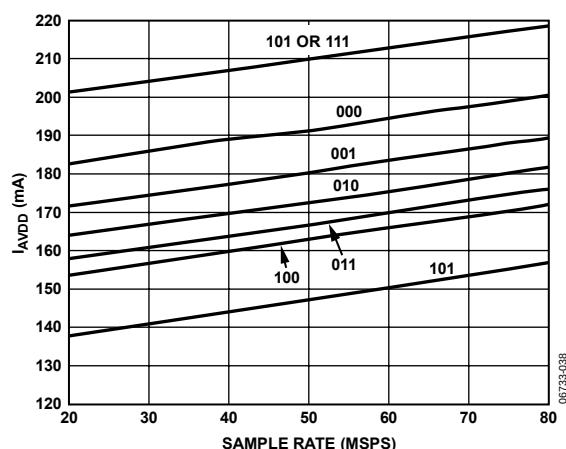


Figure 38. AVDD Current vs. ADC Bias Setting and Sample Rate

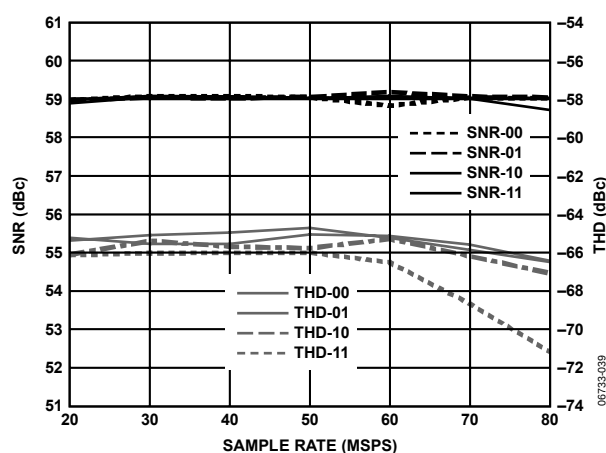


Figure 39. SNR and THD Performance vs.  $f_{ADC}$  and ADC Bias Setting with  $RxPGA = 0$  dB,  $f_{IN} = 10$  MHz,  $A_{IN} = -1$  dBFS

A sine wave input is a standard and convenient method of analyzing the performance of a system. However, the amount of power reduction that is possible is application dependent, based on the nature of the input waveform (such as frequency content, and peak-to-rms ratio), the minimum ADC sample, and the minimum acceptable level of performance. Thus, it is advisable that power-sensitive applications optimize the power bias setting of the Rx path using an input waveform that is representative of the application.

## POWER DISSIPATION

The power dissipation of the AD9868 can become quite high in full-duplex applications in which the Tx path and Rx path are simultaneously operating with nominal power bias settings. In fact, some applications that use the IAMP may need to either reduce its peak power capabilities or reduce the power consumption of the Rx path so that the device's maximum allowable power consumption,  $P_{MAX}$ , is not exceeded.

$P_{MAX}$  is specified at 1.66 W to ensure that the die temperature does not exceed 125°C at an ambient temperature of 85°C. This specification is based on the 64-lead LFSCP having a thermal resistance,  $\theta_{JA}$ , of 24°C/W with its heat slug soldered. (The  $\theta_{JA}$  is 30.8°C/W if the heat slug remains unsoldered.) If a particular application's maximum ambient temperature,  $T_A$ , falls below 85°C, the maximum allowable power dissipation can be determined by the following equation:

$$P_{MAX} = 1.66 + (85 - T_A)/24 \quad (10)$$

Assuming the IAMP common-mode bias voltage is operating off the same analog supply as the AD9868, the following equation can be used to calculate the maximum total current consumption,  $I_{MAX}$ , of the IC:

$$I_{MAX} = (P_{MAX} - P_{IAMP})/3.47 \quad (11)$$

With an ambient temperature of up to 85°C,  $I_{MAX}$  is 478 mA.

If the IAMP is operating off a different supply or in the voltage mode configuration, first calculate the power dissipated in the IAMP,  $P_{IAMP}$ , using Equation 3, and then recalculate  $I_{MAX}$  using Equation 11.

Figure 33, Figure 34, Figure 36, and Figure 38 can be used to calculate the current consumption of the Rx and Tx paths for a given setting.

## MODE SELECT UPON POWER-UP AND RESET

The AD9868 power-up state is determined by the logic levels appearing at the MODE and CONFIG pins. The MODE pin is used to select a half- or full-duplex interface by pin strapping it low or high, respectively. The CONFIG pin is used in conjunction with the MODE pin to determine the default settings for the SPI registers as outlined in Table 10.

The intent of these particular default settings is to allow some applications to avoid using the SPI (disabled by pin strapping SEN high), thereby reducing implementation costs. For example, setting MODE low and CONFIG high configures the AD9868 to be backward compatible with the AD9975, while setting MODE high and CONFIG low makes it backward compatible with the AD9875. Other applications must use the SPI to configure the device.

A hardware reset ( $\overline{\text{RESET}}$  pin) or software reset (Bit 5 of Register 0x00) can be used to place the AD9868 into a known state of operation as determined by the state of the MODE and CONFIG pins. A dc offset calibration and filter tuning routine is also initiated upon a hardware reset, but not with a software reset. Neither reset method flushes the digital interpolation filters in the Tx path. Refer to the Half-Duplex Mode and Full-Duplex Mode sections for information on flushing the digital filters.

A hardware reset can be triggered by pulsing the  $\overline{\text{RESET}}$  pin low for a minimum of 50 ns. The SPI registers are instantly reset to their default settings upon  $\overline{\text{RESET}}$  going low, whereas the dc offset calibration and filter-tuning routine is initiated upon  $\overline{\text{RESET}}$  returning high. To ensure sufficient power-on time of the various functional blocks,  $\overline{\text{RESET}}$  returning high should occur no less than 10 ms upon power-up. If a digital reset signal from a microprocessor reset circuit (such as ADM1818) is not available, a simple R-C network referenced to DVDD can be used to hold  $\overline{\text{RESET}}$  low for approximately 10 ms upon power-up.

**ANALOG AND DIGITAL LOOPBACK TEST MODES**

The AD9868 features analog and digital loopback capabilities that can assist in system debug and final test. Analog loopback routes the digital output of the ADC back into the Tx data path prior to the interpolation filters such that the Rx input signal can be monitored at the output of the TxDAC or IAMP.

As a result, the analog loopback feature can be used for a half-duplex or full-duplex interface to allow testing of the functionality of the entire IC (excluding the digital data interface).

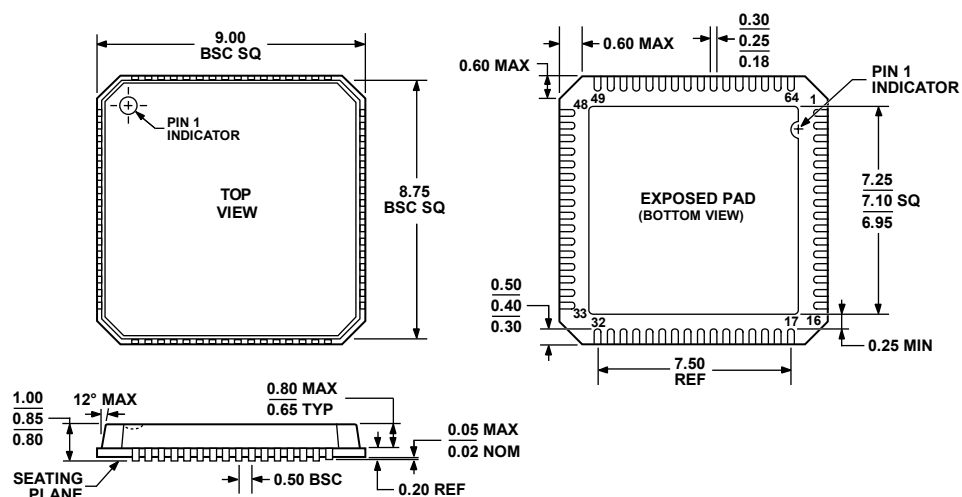
For example, the user can configure the AD9868 with similar settings as the target system, inject an input signal (sinusoidal waveform) into the Rx input, and monitor the quality of the reconstructed output from the TxDAC or IAMP to ensure a minimum level of performance. In this test, the user can exercise the RxPGA as well as validate the attenuation characteristics of the RxLPF. Note that the RxPGA gain setting should be selected such that the input does not result in clipping of the ADC.

Digital loopback can be used to test the full-duplex digital interface of the AD9868. In this test, data appearing on the Tx[5:0] port is routed back to the Rx[5:0] port, thereby confirming proper bus operation. The Rx port can also be three-stated for half-duplex and full-duplex interfaces.

**Table 26. SPI Registers for Test Modes**

| Address (Hex) | Bit | Description          |
|---------------|-----|----------------------|
| 0x0D          | 7   | Analog loopback.     |
|               | 6   | Digital loopback.    |
|               | 5   | Rx port three-state. |

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MO-220-VMM4

Figure 40. 64-Lead Lead Frame Chip Scale Package [LFCSP\_VQ]  
9 mm x 9 mm Body, Very Thin Quad  
(CP-64-3)  
Dimensions shown in millimeters

063006-B

## ORDERING GUIDE

| Model                     | Temperature Range | Package Description | Package Option |
|---------------------------|-------------------|---------------------|----------------|
| AD9868BCPZ <sup>1</sup>   | −40°C to +85°C    | 64-Lead LFCSP_VQ    | CP-64-3        |
| AD9868BCPZRL <sup>1</sup> | −40°C to +85°C    | 64-Lead LFCSP_VQ    | CP-64-3        |

<sup>1</sup> Z = RoHS Compliant Part.

**AD9868**

## NOTES

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Components Supply Platform

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